## MC68HC705P6

TECHNICAL DATA



# MC68HC705P6 HCMOS MICROCONTROLLER UNIT

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## SECTION 1 GENERAL DESCRIPTION

The MC68HC705P6 is a member of the low-cost, high-performance M68HC05 Family of 8-bit microcontroller units (MCUs). The M68HC05 Family is based on the customer-specified integrated circuit (CSIC) design strategy. All MCUs in the family use the popular M68HC05 central processor unit (CPU) and are available with a variety of subsystems, memory sizes and types, and package types.

On-chip memory of the MC68HC705P6 includes 176 bytes of user RAM and 4672 bytes of user erasable, programmable ROM (EPROM). In packages without the transparent window for EPROM erasure, the 4672 EPROM bytes serve as one-time programmable ROM (OTPROM).

#### 1.1 Features

Features of the MC68HC705P6 MCU include the following:

- Popular M68HC05 Central Processor Unit
- Memory-Mapped Input/Output (I/O) Registers
- 4672 Bytes of User EPROM/OTPROM Including 48 Bytes of Page Zero EPROM/OTPROM and 16 User Vector Locations
- 176 Bytes of User RAM
- 20 I/O Port Pins and One Input-Only Port Pin
- On-Chip Oscillator with Crystal or Ceramic Resonator Connections
- 4-Input, 8-Bit Analog-to-Digital Converter (ADC)
- Synchronous Serial I/O Port (SIOP)
- 16-Bit Capture/Compare Timer
- Fully Static Operation with no Minimum Clock Speed
- Bootloader ROM
- Computer Operating Properly (COP) Watchdog
- Power-Saving Stop, Wait, Halt, and Data-Retention Modes
- 8 × 8 Unsigned Multiply Instruction
- 28-Pin Plastic Dual In-Line Package (PDIP)
- 28-Pin Small Outline Integrated Circuit (SOIC)
- 28-Pin Ceramic DIP (Cerdip)

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#### 1.2 Programmable Options

The following options are programmable in the mask option register (MOR):

- STOP instruction: enabled or disabled
- SIOP clock rate: oscillator frequency divided by 8, 16, 32, or 64
- SIOP data format: MSB-first or LSB-first
- External interrupt pin: edge-triggered or edge- and level-triggered
- · COP watchdog: enabled or disabled

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#### 1.3 MCU Structure

Figure 1-1 shows the structure of the MC68HC705P6 MCU.

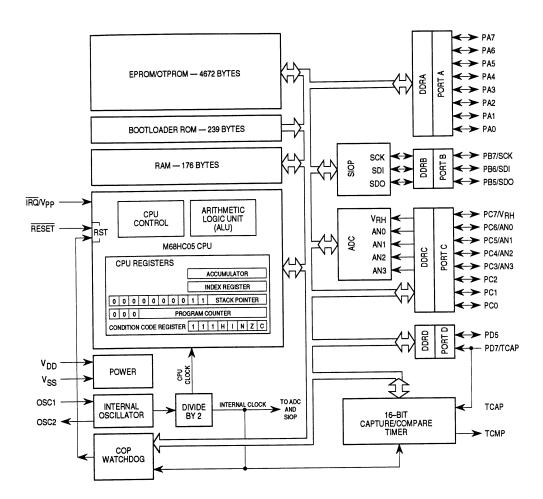


Figure 1-1. MC68HC705P6 Block Diagram

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#### 1.4 Pin Assignments

Figure 1-2 shows the MC68HC705P6 pin assignments.



Figure 1-2. Pin Assignments

#### 1.4.1 $V_{DD}$ and $V_{SS}$

 $V_{DD}$  and  $V_{SS}$  are the power supply and ground pins. The MCU operates from a single 5 V power supply.

Very fast signal transitions occur on the MCU pins, placing very high short-duration current demands on the power supply. To prevent noise problems, take special care to provide good power supply bypassing at the MCU. Place bypass capacitors as close to the MCU as possible, as Figure 1-3 shows. C2 is an optional bulk current bypass capacitor for use in applications that require the port pins to source high current levels.

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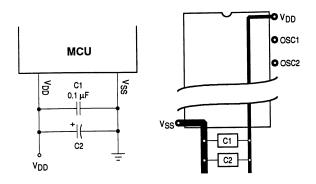


Figure 1-3. Bypassing Layout Recommendation

#### 1.4.2 OSC1 and OSC2

The OSC1 and OSC2 pins are the control connections for the on-chip oscillator. The oscillator can be driven by any of the following:

- Crystal
- · Ceramic resonator
- · External clock signal

The frequency of the internal oscillator is fosc. The MCU divides the internal oscillator output by two to produce the internal clock. The frequency of the internal clock is fop.

#### 1.4.2.1 Crystal

A crystal connected to the OSC1 and OSC2 pins can drive the on-chip oscillator. Figure 1-4 shows a typical crystal oscillator circuit for an AT-cut, parallel resonant crystal. Follow the crystal supplier's recommendations, as the crystal parameters determine the external component values required to provide reliable start-up and maximum stability. The load capacitance values used in the oscillator circuit design should include all stray layout capacitances. To minimize output distortion, mount the crystal and capacitors as close as possible to the pins.

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#### NOTE

Use an AT-cut crystal and not an AT-strip crystal. The MCU may overdrive an AT-strip crystal.

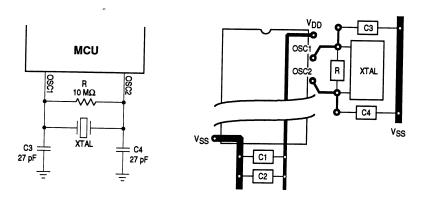


Figure 1-4. Crystal Connections

#### 1.4.2.2 Ceramic Resonator

To reduce cost, use a ceramic resonator in place of the crystal. Use the circuit in Figure 1-5 for a ceramic resonator, and follow the resonator manufacturer's recommendations. The load capacitance values used in the oscillator circuit design should include all stray layout capacitances. To minimize output distortion, mount the resonator as close as possible to the pins.

#### **NOTE**

Because the frequency stability of ceramic resonators is not as high as that of crystal oscillators, using a ceramic resonator may degrade the performance of the analog-to-digital converter (ADC).

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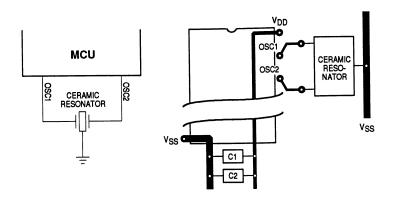


Figure 1-5. Ceramic Resonator Connections

#### 1.4.2.3 External Clock

An external clock from another CMOS-compatible device can drive the OSC1 input. Leave the OSC2 pin unconnected, as Figure 1-6 shows.

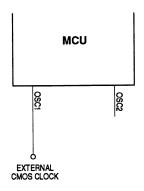


Figure 1-6. External Clock Connections

MC68HC705P6 REV. 1 GENERAL DESCRIPTION

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#### 1.4.3 **RESET**

A logic zero on the RESET pin forces the MCU to a known start-up state. (See 5.1.2 External Reset for more information.)

#### 1.4.4 **IRQ/Vpp**

The IRQ/VPP pin has the following functions:

- Applying asynchronous external interrupt signals (See 4.1.2 External Interrupt.)
- Applying EPROM programming voltage (See 11.1.1 EPROM Programming Register (EPROG).)

#### 1.4.5 PA7-PA0

PA7-PA0 are the pins of port A, a general-purpose bidirectional I/O port.

#### 1.4.6 PB7/SCK

PB7/SCK is a general-purpose bidirectional port B I/O pin. When the serial I/O port (SIOP) is enabled, PB7/SCK is the serial clock input pin (slave mode) or the serial clock output pin (master mode).

#### 1.4.7 PB6/SDI

PB6/SDI is a general-purpose bidirectional port B I/O pin. When the serial I/O port (SIOP) is enabled, PB6/SDI is the serial data input pin.

#### 1.4.8 PB5/SDO

PB5/SDO is a general-purpose bidirectional port B I/O pin. When the serial I/O port (SIOP) is enabled, PB5/SDO is the serial data output pin.

#### 1.4.9 PC7/VRH

PC7/V<sub>RH</sub> is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC7/V<sub>RH</sub> is the positive reference voltage pin for the ADC.

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#### 1.4.10 PC6/AN0

PC6/AN0 is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC6/AN0 is an analog input pin for the ADC.

#### 1.4.11 PC5/AN1

PC5/AN1 is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC5/AN1 is an analog input pin for the ADC.

#### 1.4.12 PC4/AN2

PC4/AN2 is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC4/AN2 is an analog input pin for the ADC.

#### 1.4.13 PC3/AN3

PC3/AN3 is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC3/AN3 is an analog input pin for the ADC.

#### 1.4.14 PC2-PC0

PC2-PC0 are general-purpose bidirectional port C I/O pins.

#### 1.4.15 PD7/TCAP

PD7/TCAP serves as both a general-purpose input-only port D I/O pin and as the input capture line for the capture/compare timer.

#### 1.4.16 PD5

PD5 is a general-purpose bidirectional port D I/O pin.

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#### 1.4.17 TCMP

TCMP is the output pin for the output compare function of the capture/compare timer.

MOTOROLA 1-10 GENERAL DESCRIPTION

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#### SECTION 2 MEMORY

This section describes the organization of the on-chip memory.

#### 2.1 Memory Map

The CPU can address 8 Kbytes of memory space. The ROM portion of memory holds the program instructions, fixed data, user-defined vectors, and interrupt service routines. The RAM portion of memory holds variable data. I/O registers are memory-mapped so that the CPU can access their locations in the same way that it accesses all other memory locations. Figure 2-1 is a memory map of the MCU.

#### 2.2 Input/Output Section

The first 32 addresses of the memory space, \$0000-\$001F, are the I/O section. These are the addresses of the I/O control registers, status registers, and data registers. (See Figure 2-2.)

Two of the I/O registers shown in Figure 2-2 are located outside the 32-byte I/O section: the mask option register (MOR) is mapped at \$1F00, and the computer operating properly (COP) register is mapped at \$1FF0.

#### 2.3 RAM

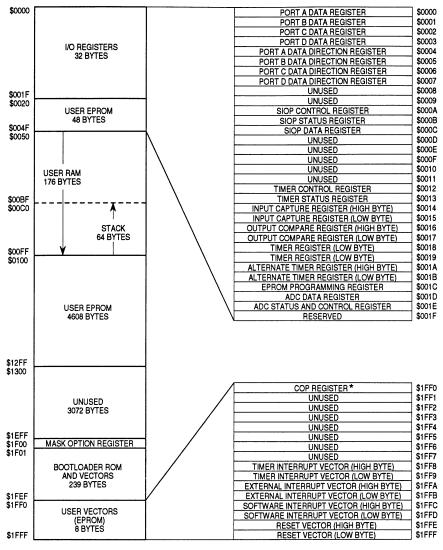
The 176 addresses from \$0050 to \$00FF are RAM locations. The CPU uses the top 64 RAM addresses, \$00C0-\$00FF, as the stack. Before processing an interrupt, the CPU uses five bytes of the stack to save the contents of the CPU registers. During a subroutine call, the CPU uses two stack bytes to store the return address. The stack pointer decrements during pushes and increments during pulls.

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#### NOTE

Be careful when using nested subroutines or multiple interrupt levels. The CPU may overwrite data in the RAM during a subroutine or during the interrupt stacking operation.



<sup>\*</sup> Writing zero to bit 0 of \$1FF0 clears the COP watchdog timer. Reading \$1FF0 returns user ROM data.

Figure 2-1. Memory Map

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,	Bit 7	6	5	4	3	2	1	Bit 0	DODTA
\$0000	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0	PORTA
\$0001	PB7	PB6	PB5	0	0	0	0	0	PORTB
\$0002	PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0	PORTC
\$0003	PD7	0	PD5	1	0	0	0	0	PORTD
\$0004	DDRA7	DDRA6	DDRA5	DDRA4	DDRA3	DDRA2	DDRA1	DDRA0	DDRA
\$0005	DDRB7	DDRB6	DDRB5	1	1	1	1	1	DDRB
\$0006	DDRC7	DDRC6	DDRC5	DDRC4	DDRC3	DDRC2	DDRC1	DDRC0	DDRC
\$0007	0	0	DDRD5	0	0	0	0	0	DDRD
\$0008					_	_			UNUSED
\$0009									UNUSED
\$000A	0	SPE	0	MSTR	0	0	0	0	SCR
\$000B	SPIF	DCOL	0	0	0	0	0	0	SSR
\$000C	Bit 7	6	5	4	3	2	1	Bit 0	SDR
\$000D									RESERVED
\$000E									UNUSED
\$000F				_				_	UNUSED
\$0010		_						_	UNUSED
\$0011									UNUSED
\$0012	ICIE	OCIE	TOIE	0	0	0	IEDG	OLVL	TCR
\$0013	ICF	OCF	TOF	0	0	0	0	0	TSR
\$0014	Bit 15	14	13	12	11	10	9	Bit 8	ICRH
\$0015	Bit 7	6	5	4	3	2	1	Bit 0	ICRL
\$0016	Bit 15	14	13	12	11	10	9	Bit 8	OCRH
\$0017	Bit 7	6	5	4	3	2	1	Bit 0	OCRL
\$0018	Bit 15	14	13	12	11	10	9	Bit 8	TCRH
\$0019	Bit 7	6	5	4	3	2	1	Bit 0	TCRL
\$001A	Bit 15	14	13	12	11	10	9	Bit 8	ACRH
\$001B	Bit 7	6	5	4	3	2	1	Bit 0	ACRL
\$001C	0	0	0	0	0	ELAT	MPGM	EPGM	EPROG
\$001D	Bit 7	6	5	4	3	2	1	Bit 0	ADDR
\$001E	$\infty$	ADRC	ADON	0	0	CH2	CH1	CH0	ADSCR
\$001F			_					_	RESERVED
									•
\$1F00			SWAIT	SPR1	SPR0	LSBF	LEVEL	COP	MOR
\$1FF0				-				COPC	COPR

Figure 2-2. I/O Registers

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#### 2.4 EPROM/OTPROM

Packages with transparent windows have 4672 bytes of erasable programmable ROM (EPROM). The transparent window allows EPROM erasure with ultraviolet light. Packages without the transparent window do not allow EPROM erasure, and the EPROM serves as one-time programmable ROM (OTPROM). The EPROM/OTPROM is located in three areas of the memory map:

- Addresses \$0020-\$004F contain 48 bytes of page zero EPROM/OTPROM.
- Addresses \$0100-\$12FF contain 4608 bytes of EPROM/OTPROM.
- Addresses \$1FF0-\$1FFF contain 16 bytes of EPROM/OTPROM reserved for vectors.

#### 2.5 Bootloader ROM

Addresses \$1F01-\$1FEF contain the bootloader ROM, which can copy and verify the contents of an external EPROM to the on-chip EPROM/OTPROM. (See 11.1 EPROM/OTPROM Programming.)

MOTOROLA 2-4 **MEMORY** 

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## SECTION 3 CENTRAL PROCESSOR UNIT

This section describes the CPU registers.

#### 3.1 CPU Registers

Figure 3-1 shows the five CPU registers. CPU registers are not part of the memory map.

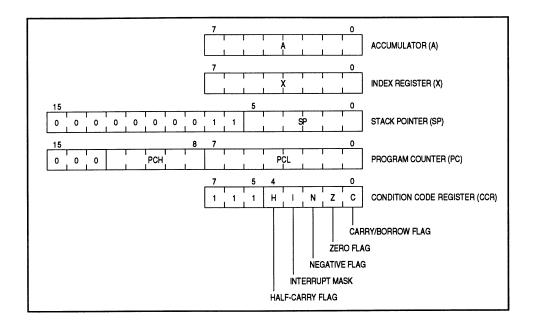


Figure 3-1. Programming Model

MC68HC705P6 REV. 1 CENTRAL PROCESSOR UNIT

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#### 3.1.1 Accumulator

The accumulator is a general-purpose 8-bit register. The CPU uses the accumulator to hold operands and results of arithmetic and nonarithmetic operations.



Figure 3-2. Accumulator

#### 3.1.2 Index Register

In the indexed addressing modes, the CPU uses the byte in the index register to determine the conditional address of the operand. (See **12.1 Addressing Modes**.)

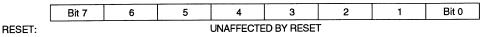


Figure 3-3. Index Register

The 8-bit index register can also serve as a temporary data storage location.

MOTOROLA 3-2 CENTRAL PROCESSOR UNIT

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#### 3.1.3 Stack Pointer

The stack pointer is a 16-bit register that contains the address of the next location on the stack. During a reset or after the reset stack pointer (RSP) instruction, the stack pointer is preset to \$00FF. The address in the stack pointer decrements as data is pushed onto the stack and increments as data is pulled from the stack.

	Bit15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	Bit 0
	0	0	0	0	0	0	0	0	1	1						
RESET:	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1

Figure 3-4. Stack Pointer

The ten most significant bits of the stack pointer are permanently fixed at 0000000011, so the stack pointer produces addresses from \$00C0 to \$00FF. If subroutines and interrupts use more than 64 stack locations, the stack pointer wraps around to address \$00FF and begins writing over the previously stored data. A subroutine uses two stack locations; an interrupt uses five locations.

MC68HC705P6 REV. 1 **CENTRAL PROCESSOR UNIT** 

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#### 3.1.4 Program Counter

The program counter is a 16-bit register that contains the address of the next instruction or operand to be fetched. The three most significant bits of the program counter are ignored internally and appear as 000.

Normally, the address in the program counter automatically increments to the next sequential memory location every time an instruction or operand is fetched. Jump, branch, and interrupt operations load the program counter with an address other than that of the next sequential location.

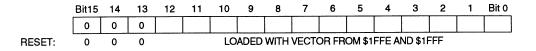


Figure 3-5. Program Counter

#### 3.1.5 Condition Code Register

The condition code register is an 8-bit register whose three most significant bits are permanently fixed at 111. The condition code register contains the interrupt mask and four flags that indicate the results of the instruction just executed. The following paragraphs describe the functions of the condition code register.

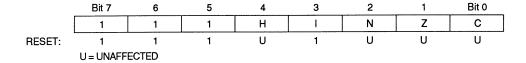


Figure 3-6. Condition Code Register

MOTOROLA 3-4 CENTRAL PROCESSOR UNIT

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#### 3.1.5.1 Half-Carry Flag (H)

The CPU sets the half-carry flag when a carry occurs between bits 3 and 4 of the accumulator during an ADD or ADC operation. The half-carry flag is required for binary-coded decimal (BCD) arithmetic operations.

#### 3.1.5.2 Interrupt Mask (I)

Setting the interrupt mask disables interrupts. If an interrupt request occurs while the interrupt mask is logic zero, the CPU saves the CPU registers on the stack, sets the interrupt mask, and then fetches the interrupt vector. If an interrupt request occurs while the interrupt mask is set, the interrupt request is latched. Normally, the CPU processes the latched interrupt as soon as the interrupt mask is cleared again.

A return from interrupt (RTI) instruction pulls the CPU registers from the stack, restoring the interrupt mask to its cleared state. After any reset, the interrupt mask is set and can be cleared only by a software instruction.

#### 3.1.5.3 Negative Flag (N)

The CPU sets the negative flag when an arithmetic operation, logical operation, or data manipulation produces a negative result.

#### 3.1.5.4 Zero Flag (Z)

The CPU sets the zero flag when an arithmetic operation, logical operation, or data manipulation produces a result of \$00.

#### 3.1.5.5 Carry/Borrow Flag (C)

The CPU sets the carry/borrow flag when an addition operation produces a carry out of bit 7 of the accumulator or when a subtraction operation requires a borrow. Some logical operations and data manipulation instructions also clear or set the carry/borrow flag.

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#### 3.2 Arithmetic/Logic Unit (ALU)

The ALU performs the arithmetic and logical operations defined by the instruction set.

The binary arithmetic circuits decode instructions and set up the ALU for the selected operation. Most binary arithmetic is based on the addition algorithm, carrying out subtraction as negative addition. Multiplication is not performed as a discrete operation but as a chain of addition and shift operations within the ALU. The multiply instruction (MUL) requires 11 internal processor cycles to complete this chain of operations.

MOTOROLA 3-6 **CENTRAL PROCESSOR UNIT** 

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# SECTION 4 INTERRUPTS

This section describes how interrupts temporarily change the normal processing sequence.

#### 4.1 Interrupt Sources

The following sources can generate interrupt requests:

- SWI instruction
- IRQ/V<sub>PP</sub> pin
- Capture/compare timer

An interrupt temporarily stops normal program execution to process a particular event. An interrupt does not stop the execution of the instruction in progress, but takes effect when the current instruction completes its execution. Interrupt processing automatically saves the CPU registers on the stack and loads the program counter with a user-defined interrupt vector address.

### 4.1.1 Software Interrupt

The software interrupt (SWI) instruction causes a nonmaskable interrupt.

### 4.1.2 External Interrupt

An interrupt signal on the IRQ/VPP pin latches an external interrupt request. When the CPU completes its current instruction, it tests the IRQ latch. If the IRQ latch is set, the CPU then tests the I bit in the condition code register. If the I bit is clear, the CPU then begins the interrupt sequence. The CPU clears the IRQ latch while it fetches the interrupt vector, so another external interrupt request can be latched during the interrupt service routine. As soon as the I bit is cleared during the return from interrupt, the CPU can recognize the new interrupt request.

MC68HC705P6 REV. 1 **INTERRUPTS** 

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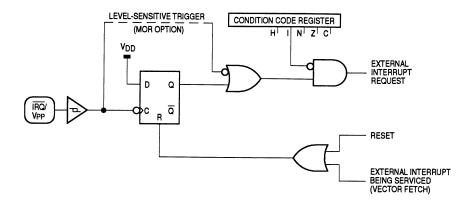


Figure 4-1. External Interrupt Logic

Interrupt triggering sensitivity of the  $\overline{IRQ}/V_{PP}$  pin is a programmable option. The  $\overline{IRQ}/V_{PP}$  pin can be negative edge-triggered or negative edge- and low level-triggered. The low level-sensitive triggering option allows the wired-OR use of multiple external interrupt sources. An external interrupt request is latched as long as any source is holding the  $\overline{IRQ}/V_{PP}$  pin low.

MOTOROLA 4-2 INTERRUPTS

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### 4.1.3 Timer Interrupts

The capture/compare timer can generate the following interrupts:

- Input capture interrupt
- Output compare interrupt
- Timer overflow interrupt

Setting the I bit in the condition code register disables timer interrupts.

#### 4.1.3.1 Input Capture Interrupt

An input capture interrupt request occurs if the input capture flag, ICF, becomes set while the input capture interrupt enable bit, ICIE, is also set. ICF is in the timer status register, and ICIE is in the timer control register. (See SECTION 8 CAPTURE/COMPARE TIMER.)

### 4.1.3.2 Output Compare Interrupt

An output compare interrupt request occurs if the output compare flag, OCF, becomes set while the output compare interrupt enable bit, OCIE, is also set. OCF is in the timer status register, and OCIE is in the timer control register. (See SECTION 8 CAPTURE/COMPARE TIMER.)

### 4.1.3.3 Timer Overflow Interrupt

A timer overflow interrupt request occurs if the timer overflow flag, TOF, becomes set while the timer overflow interrupt enable bit, TOIE, is also set. TOF is in the timer status register, and TOIE is in the timer control register. (See SECTION 8 CAPTURE/COMPARE TIMER.)

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#### 4.2 Interrupt Processing

The CPU begins servicing an interrupt by taking the following actions:

- Stores the CPU registers on the stack in the order shown in Figure 4-2
- Sets the I bit in the condition code register to prevent further interrupts
- Loads the program counter with the contents of the appropriate interrupt vector locations:
  - \$1FFC and \$1FFD (software interrupt vector)
  - \$1FFA and \$1FFB (external interrupt vector)
  - \$1FF8 and \$1FF9 (timer interrupt vector)

The return from interrupt (RTI) instruction causes the CPU to recover the CPU registers from the stack as shown in Figure 4-2.

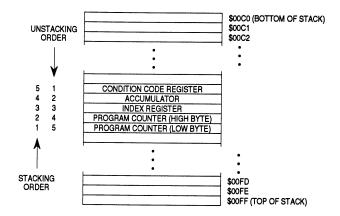


Figure 4-2. Interrupt Stacking Order

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INTERRUPTS

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Table 4-1 summarizes the reset and interrupt sources and vector assignments.

Table 4-1. Reset/Interrupt Vector Addresses

Function	Source	Local Mask	Globai Mask	Priority (1 = Highest)	Vector Address
Reset	Power-On RESET Pin COP Watchdog*	None	None	1 1 1	\$1FFE-\$1FFF
Software Interrupt (SWI)	User Code	None	None	Same Priority As Instruction	\$1FFC-\$1FFD
External Interrupt	IRQ/V <sub>PP</sub> Pin	None	l Bit	2	\$1FFA-\$1FFB
Timer Interrupts	ICF Bit OCF Bit TOF Bit	ICIE Bit OCIE Bit TOIE Bit	l Bit	3	\$1FF8-\$1FF9

<sup>\*</sup>The COP watchdog is a programmable option.

MC68HC705P6 REV. 1 **INTERRUPTS** 

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Figure 4-3 shows the sequence of events caused by an interrupt.

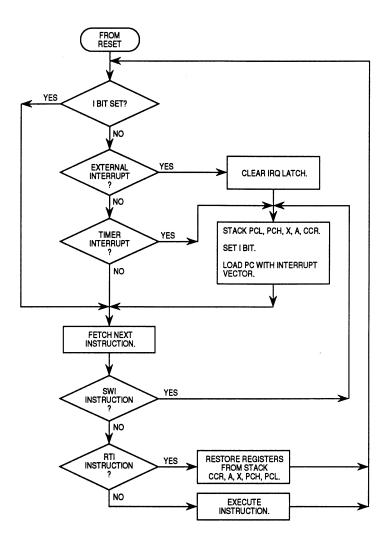


Figure 4-3. Interrupt Flowchart

MOTOROLA INTERRUPTS 4-6

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# SECTION 5 RESETS

This section describes the three reset sources and how they initialize the MCU.

#### 5.1 Reset Sources

The following sources can generate resets:

- · Power-on reset (POR) circuit
- RESET pin
- COP watchdog

A reset immediately stops the execution of the instruction in progress, initializes certain control bits, and loads the program counter with a user-defined reset vector address. Figure 5-1 is a block diagram of the reset sources.

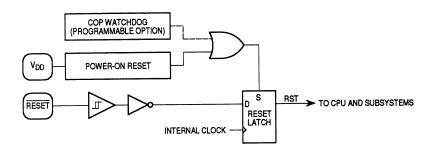


Figure 5-1. Reset Sources

#### 5.1.1 Power-On Reset

A positive transition on the  $V_{DD}$  pin generates a power-on reset. The power-on reset is strictly for power-up conditions and cannot be used to detect drops in power supply voltage.

MC68HC705P6 RESETS MOTOROLA REV. 1 5-1

A 4064 t<sub>CYC</sub> (internal clock cycle) delay after the oscillator becomes active allows the clock generator to stabilize. If the  $\overline{\text{RESET}}$  pin is at logic zero at the end of 4064 t<sub>CYC</sub>, the MCU remains in the reset condition until the signal on the  $\overline{\text{RESET}}$  pin goes to logic one.

#### 5.1.2 External Reset

A logic zero applied to the  $\overline{\text{RESET}}$  pin for one and one-half  $t_{\text{CYC}}$  generates an external reset. A Schmitt trigger senses the logic level at the  $\overline{\text{RESET}}$  pin. Figure 5-2 shows an example of an external reset circuit with an open-collector low voltage inhibit device and a pullup resistor.

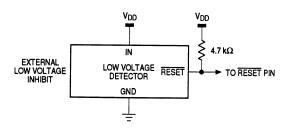


Figure 5-2. Typical External Reset Circuit

### 5.1.3 Computer Operating Properly (COP) Watchdog Reset

A timeout of the 18-stage ripple counter in the COP watchdog generates a COP reset. The COP watchdog is part of a software error detection system and must be cleared periodically to start a new timeout period. With a 4-MHz oscillator, the COP timeout period is 65.5 ms. To clear the COP watchdog and prevent a COP reset, write a logic zero to bit 0 (COPC) of the COP register at location \$1FF0. The COP register, shown in Figure 5-3, is a write-only register that returns the contents of an EPROM location when read.

The COP watchdog function is programmable in the mask option register.

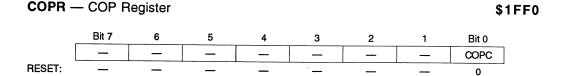


Figure 5-3. COP Register (COPR)

MOTOROLA RESETS MC68HC705P6
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COPC — COP Clear

COPC is a write-only bit. Periodically writing a logic zero to COPC prevents the COP watchdog from resetting the MCU.

#### 5.2 Reset States

The following paragraphs describe how resets initialize the MCU.

#### 5.2.1 CPU

A reset has the following effects on the CPU:

- Loads the stack pointer with \$FF
- Sets the I bit in the condition code register, inhibiting interrupts
- Loads the program counter with the user-defined reset vector from locations \$1FFE and \$1FFF
- · Clears the stop latch, enabling the CPU clock
- Clears the wait latch, waking the CPU from the wait mode

#### 5.2.2 I/O Port Registers

A reset has the following effects on I/O port registers:

- Clears data direction registers A, B, C, and D so that all I/O port pins are inputs (PD7/TCAP remains an input-only pin.)
- Has no effect on port A, port B, port C, or port D data registers

#### 5.2.3 Capture/Compare Timer

A reset has the following effects on the capture/compare timer:

- · Loads the timer counter with \$FFFC
- Clears the timer control register, except for the IEDG bit, with the following results:
  - Clears the ICIE bit, inhibiting input capture interrupts
  - Clears the OCIE bit, inhibiting output compare interrupts
  - Clears the TOIE bit, inhibiting timer overflow interrupts

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- Clears OLVL, the output compare bit
- Clears the TCMP pin
- Has no effect on the ICF, OCF, and TOF flags in the timer status register

### 5.2.4 Serial I/O Port (SIOP)

A reset clears the SIOP control and status registers and produces the following results:

- Clears the SPE bit, disabling the SIOP
- Clears the MSTR bit, configuring the disabled SIOP for slave mode operation
- Clears the SPIF and DCOL flags

### 5.2.5 COP Watchdog

A reset clears the COP watchdog counter.

### 5.2.6 Analog-to-Digital Converter (ADC)

A reset clears the ADC status and control register and produces the following results:

- Clears the ADON bit, disabling the ADC
- Clears the CCF flag
- Clears the ADRC bit, configuring the disabled ADC for operation at internal clock frequency
- Clears bits CH2-CH0, selecting channel 0 as the analog input

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RESETS

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#### SECTION 6 LOW POWER MODES

This section describes the four low power modes:

- Stop mode
- Wait mode
- Halt mode (programmable option)
- · Data-retention mode

#### 6.1 Stop Mode

The STOP instruction puts the MCU in its lowest power-consumption mode and has the following effects on the MCU:

- Stops the internal oscillator, the CPU clock, and the internal clock, turning off the capture/compare timer, the COP watchdog, the SIOP, and the ADC
- Clears the I bit in the condition code register, enabling external interrupts
- Clears the ICF, OCF, and TOF interrupt flags in the timer status register, removing any pending timer interrupts
- Clears the ICIE, OCIE, and TOIE bits in the timer control register, disabling further timer interrupts

The STOP instruction does not affect any other registers or any I/O lines.

MC68HC705P6 REV. 1 LOW POWER MODES

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The following events bring the MCU out of stop mode:

- External interrupt A high-to-low transition on the IRQ/V<sub>PP</sub> pin loads the program counter with the contents of locations \$1FFA and \$1FFB.
- External reset A logic zero on the RESET pin resets the MCU and loads the program counter with the contents of locations \$1FFE and \$1FFF.

When the MCU exits stop mode, processing resumes after a stabilization delay of 4064 oscillator cycles.

If an external interrupt brings the MCU out of stop mode after an active edge occurred on the PD7/TCAP pin during stop mode, the ICF flag becomes set. An external interrupt also latches the value in the timer registers into the input capture registers.

If an external reset brings the MCU out of stop mode after an active edge occurred on the PD7/TCAP pin during stop mode, the ICF flag does not become set. An external reset has no effect on the input capture registers.

#### 6.2 Wait Mode

The WAIT instruction puts the MCU in an intermediate power-consumption mode and has the following effects on the MCU:

- Clears the I bit in the condition code register, enabling interrupts
- Stops the CPU clock, but allows the internal oscillator and internal clock to continue to run

The WAIT instruction does not affect any other registers or any I/O lines.

The following events restart the CPU clock and bring the MCU out of wait mode:

- External interrupt A high-to-low transition on the IRQ/V<sub>PP</sub> pin loads the program counter with the contents of locations \$1FFA and \$1FFB.
- Timer interrupt Input capture, output compare, and timer overflow interrupts load the program counter with the contents of locations \$1FF8 and \$1FF9.

MOTOROLA 6-2 LOW POWER MODES

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- COP watchdog reset A timeout of the COP watchdog resets the MCU and loads the program counter with the contents of locations \$1FFE and \$1FFF. Software can enable timer interrupts so that the MCU can periodically exit wait mode to reset the COP watchdog.
- External reset A logic zero on the RESET pin resets the MCU and loads the program counter with the contents of locations \$1FFE and \$1FFF.

#### 6.3 Halt Mode

If the SWAIT bit in the mask option register is programmed to logic one, a STOP instruction puts the MCU in halt mode. The halt mode is identical to the wait mode, except that a recovery delay of 1–4064 internal clock cycles occurs when the MCU exits the halt mode. If SWAIT is programmed to logic one, the COP watchdog cannot be inadvertently turned off by a STOP instruction.

Figure 6-1 shows the sequence of events in stop, wait, and halt modes.

### 6.4 Data-Retention Mode

In data-retention mode, the MCU retains RAM contents and CPU register contents at  $V_{DD}$  voltages as low as 2.0 Vdc. The data-retention feature allows the MCU to remain in a low power-consumption state during which it retains data, but the CPU cannot execute instructions.

To put the MCU in data-retention mode:

- 1. Drive the RESET pin to logic zero.
- 2. Lower the V<sub>DD</sub> voltage. The RESET pin must remain low continuously during data-retention mode.

To take the MCU out of data-retention mode:

- 1. Return  $V_{DD}$  to normal operating voltage.
- 2. Return the RESET pin to logic one.

MC68HC705P6 REV. 1 LOW POWER MODES

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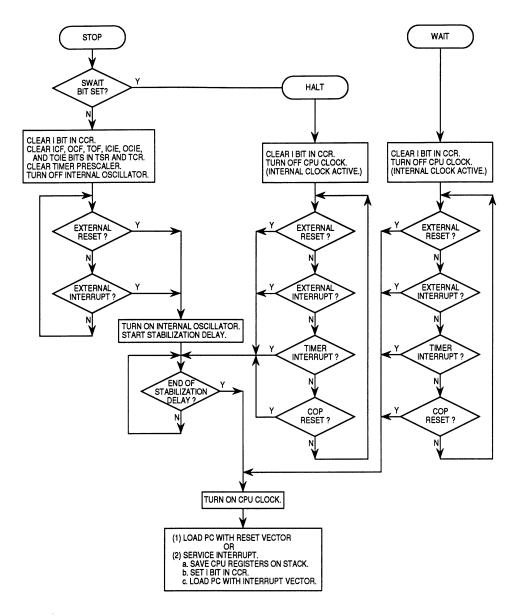


Figure 6-1. STOP/HALT/WAIT Flowchart

MOTOROLA LOW POWER MODES MC68HC705P6
6-4 REV. 1

# SECTION 7 PARALLEL I/O

This section describes the four bidirectional I/O ports.

### 7.1 I/O Port Function

Twenty bidirectional I/O pins and one input-only pin form four parallel I/O ports. The 20 bidirectional I/O pins are programmable as inputs or outputs through the four data direction registers.

#### NOTE

Connect any unused inputs and I/O pins to an appropriate logic level, either  $V_{DD}$  or  $V_{SS}$ . Although the I/O ports do not require termination for proper operation, termination reduces excess current consumption and the possibility of electrostatic damage.

#### 7.2 Port A

Port A is an 8-bit general-purpose bidirectional I/O port.

### 7.2.1 Port A Data Register (PORTA)

The port A data register, shown in Figure 7-1, contains a data latch for each of the eight port A pins.

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#### PORTA — Port A Data Register

\$0000

	Bit 7	6	5	4	3	2	1	Bit 0
	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0
RESET:				UNAFFECTE	D BY RESE	Γ		

Figure 7-1. Port A Data Register (PORTA)

#### PA7-PA0 - Port A Data Bits

These read/write bits are software-programmable. Data direction of each bit is under the control of the corresponding bit in data direction register A. Resets have no effect on port A data.

### 7.2.2 Data Direction Register A (DDRA)

Data direction register A, shown in Figure 7-2, determines whether each port A pin is an input or an output. Writing a logic one to a DDRA bit enables the output buffer for the corresponding port A pin; a logic zero disables the output buffer.

### DDRA — Data Direction Register A

\$0004

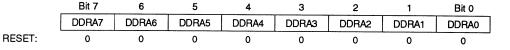


Figure 7-2. Data Direction Register A (DDRA)

#### DDRA7-DDRA0 - Port A Data Direction Bits

These read/write bits control port A data direction. A reset clears all DDRA bits, configuring all port A pins as inputs.

- 1 = Corresponding port A pin configured as output
- 0 = Corresponding port A pin configured as input

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#### NOTE

Avoid glitches on port A pins by writing to the port A data register before changing data direction register A bits from 0 to 1.

Figure 7-3 shows the port A I/O logic.

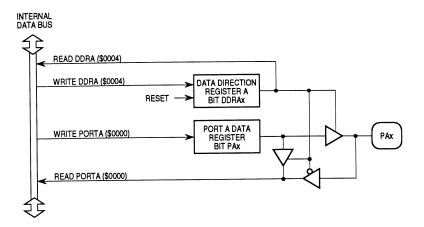


Figure 7-3. Port A I/O Circuit

When a port A pin is programmed as an output, reading the port bit reads the value of the data latch and not the voltage on the pin. When a port A pin is programmed as an input, reading the port bit reads the voltage level on the pin. The data register can always be written, regardless of the state of its DDRA bit. Table 7-1 summarizes the operations of the port A pins.

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Table 7-1. Port A Pin Functions

DDRA Bit	PORTA Bit	I/O Pin Mode	Accesses to DDRA Read/Write		ORTA Write
0	Х	Input, hi-Z	DDRA7-0	Pin	NOTE 2
1	Х	Output	DDRA7-0	PA7-0	PA7-0

#### NOTES:

- 1. X = don't care.
- 2. Writing affects data register, but does not affect input.
- 3. Hi-Z = high impedance.

#### 7.3 Port B

Port B is a 3-bit general-purpose bidirectional I/O port that shares its pins with the serial I/O port (SIOP) subsystem. Port B is available for general-purpose I/O functions when the SIOP is disabled. While the SIOP is enabled and a serial data transmission is in progress, writing to the port B data register or to bits DDRB7–5 of data direction register B can corrupt the SIOP data. (See 9.2.1 SIOP Control Register (SCR).)

#### 7.3.1 Port B Data Register (PORTB)

The port B data register, shown in Figure 7-4, contains a data latch for each of the three port B pins.

#### **PORTB** — Port B Data Register

\$0001

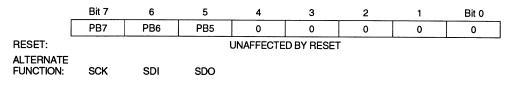


Figure 7-4. Port B Data Register (PORTB)

#### PB7-PB5 — Port B Data Bits

These read/write bits are software-programmable. Data direction of each bit is under the control of the corresponding bit in data direction register B. Resets have no effect on port B data.

#### Bits 4-0 - Not used

Bits 4-0 always read as logic zeros. Writes to these bits have no effect.

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MC68HC705P6

### 7.3.2 Data Direction Register B (DDRB)

Data direction register B determines whether each port B pin is an input or an output. (See Figure 7-5.) Writing a logic one to a DDRB bit enables the output buffer for the corresponding port B pin; a logic zero disables the output buffer.

### **DDRC** — Data Direction Register B

\$0005

	Bit 7	6	5	4	3	2	1	Bit 0	
	DDRB7	DDRB6	DDRB5	1	1	1	11	11	
RESET:	0	0	0	1	1	1	1	1	

Figure 7-5. Data Direction Register B (DDRB)

DDRB7-DDRB5 - Port B Data Direction Bits

These read/write bits control port B data direction. A reset clears DDRB7-DDRB5, configuring pins PB7-PB5 as inputs.

- 1 = Corresponding port B pin configured as output
- 0 = Corresponding port B pin configured as input

Bits 4-0 - Not used

Bits 4-0 always read as logic ones. Writes to these bits have no effect.

#### NOTE

Avoid glitches on port B pins by writing to the port B data register before changing data direction register B bits from 0 to 1.

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Figure 7-6 shows the port B I/O logic.

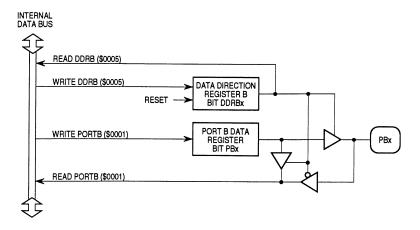


Figure 7-6. Port B I/O Circuit

When a port B pin is programmed as an output, reading the port bit actually reads the value of the data latch and not the voltage on the pin. When a port B pin is programmed as an input, reading the port bit reads the voltage level on the pin. The data latch can always be written, regardless of the state of its DDRB bit. Table 7-2 summarizes the operation of the port B pins.

Table 7-2. Port B Pin Functions

DDRB Bit	PORTB Bit	I/O Pin Mode	Accesses to DDRB	Accesses to PORTB	
			Read/Write	Read	Write
0	x	Input, hi-Z	DDRB7-5	Pin	NOTE 2
1	X	Output	DDRB7-5	PB7-5	PB7-5

#### NOTES:

- 1. X = don't care.
- 2. Writing affects data register, but does not affect input.
- 3. Hi-Z = high impedance.

MOTOROLA 7-6 PARALLEL I/O

MC68HC705P6

#### 7.4 Port C

Port C is an 8-bit general-purpose bidirectional I/O port that shares five of its pins with the analog-to-digital converter (ADC) subsystem. The five shared pins are available for general-purpose I/O functions when the ADC is disabled. While the ADC is enabled, writing to bits PC7–3 of the port C data register or to bits DDRC7–3 of data direction register C can produce unpredictable ADC results. (See 10.2.1 ADC Status and Control Register (ADSCR).)

### 7.4.1 Port C Data Register (PORTC)

The port C data register, shown in Figure 7-7, contains a data latch for each of the eight port C pins.

#### **PORTC** — Port C Data Register

\$0002

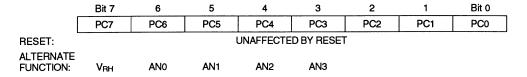


Figure 7-7. Port C Data Register (PORTC)

#### PC7-PC0 - Port C Data Bits

These read/write bits are software-programmable. Data direction of each bit is under the control of the corresponding bit in data direction register C. Resets have no effect on port C data.

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### 7.4.2 Data Direction Register C (DDRC)

Data direction register C determines whether each port C pin is an input or an output. (See Figure 7-8.) Writing a logic one to a DDRC bit enables the output buffer for the corresponding port C pin; a logic zero disables the output buffer. A reset initializes all DDRC bits to logic zero, configuring all port C pins as inputs.

DDRC — Data Direction Register C

\$0006

	Bit 7	6	5	4	3	2	1	Bit 0
	DDRC7	DDRC6	DDRC5	DDRC4	DDRC3	DDRC2	DDRC1	DDRC0
RESET:	0	0	0	0	0	0	0	0

Figure 7-8. Data Direction Register C (DDRC)

DDRC7-DDRC0 - Port C Data Direction Bits

These read/write bits control port C data direction. A reset clears all DDRC bits, configuring all port C pins as inputs.

- 1 = Corresponding port C pin configured as output
- 0 = Corresponding port C pin configured as input

#### NOTE

Avoid glitches on port C pins by writing to the port C data register before changing data direction register C bits from 0 to 1.

MOTOROLA 7-8 PARALLEL I/O

MC68HC705P6 REV. 1

Figure 7-9 shows the port C I/O logic.

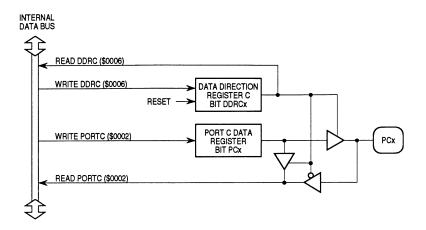


Figure 7-9. Port C I/O Circuit

When a port C pin is programmed as an output, reading the port bit actually reads the value of the data latch and not the voltage on the pin. When a port C pin is programmed as an input, reading the port bit reads the voltage level on the pin. The data register can always be written, regardless of the state of its DDRC bit. Table 7-3 summarizes the operation of the port C pins.

Table 7-3. Port C Pin Functions

DDRC Bit	PORTC Bit	I/O Pin Mode	Accesses to DDRC	Accesses to PORTC		
			Read/Write	Read	Write	
0	x	Input, hi-Z	DDRC7-0	Pin	NOTE 2	
1	X	Output	DDRC7-0	PC7-0	PC7-0	

#### NOTES:

- 1. X = don't care.
- 2. Writing affects data register, but does not affect input.
- 3. Hi-Z = high impedance.

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#### 7.5 Port D

Port D is a 2-bit general-purpose I/O port with one bidirectional pin, PD5, and one input-only pin, PD7/TCAP. Port D shares pin PD7/TCAP with the capture/compare timer. PD7/TCAP is always available for general-purpose I/O functions, and the state of the pin can be read from the port D data register at any time.

#### 7.5.1 Port D Data Register (PORTD)

The port D data register, shown in Figure 7-10, contains a data latch for each of the two port D pins.

#### **PORTD** — Port D Data Register

\$0003

Bit 7	6	5	4	3	2	1	Bit 0
PD7	0	PD5	1	0	0	0	0

RESET:

**UNAFFECTED BY RESET** 

ALTERNATE

FUNCTION: TCAP

Figure 7-10. Port D Data Register (PORTD)

PD7 — This read/write bit is software-programmable. The PD7/TCAP pin can be a general-purpose input even when the timer is using it as the input capture pin. Resets have no effect on PD7.

PD5 — This read/write bit is software-programmable. Data direction of PD5 is under the control of bit DDRD5 in data direction register D. Resets have no effect on PD5.

Bit 6 and Bits 4-0 - Not used

Bit 6 and bits 4-0 always read as logic zeros. Writes to these bits have no effect.

**MOTOROLA** 7-10

PARALLEL I/O

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#### 7.5.2 Data Direction Register D (DDRD)

Bit DDRD5 in data direction register D, shown in Figure 7-11, determines whether pin PD5 is an input or an output. Writing a logic one to bit DDRD5 enables the output buffer for pin PD5; a logic zero disables the output buffer.

**DDRD** — Data Direction Register D

\$0007

	Bit 7	6	5	4	3	2	1	Bit 0
	0	0	DDRD5	0	0	0	0	0
RESET:	0	0	0	0	0	0	0	0

Figure 7-11. Data Direction Register D (DDRD)

DDRD5 - PD5 Data Direction Bit

This read/write bit controls pin PD5 data direction. A reset clears DDRD5, configuring pin PD5 as an input.

- 1 = Pin PD5 configured as output
- 0 = Pin PD5 configured as input

Bits 7-6 and bits 4-0 - Not used

Bits 7-6 and 4-0 always read as logic zeros. Writes to these bits have no effect.

#### NOTE

Avoid glitches on PD5 by writing to PD5 before changing DDRD5 from 0 to 1.

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Figure 7-12 shows the port D I/O logic.

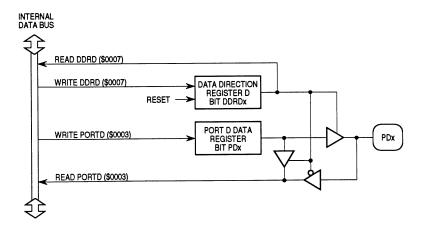


Figure 7-12. Port D I/O Circuit

When pin PD5 is programmed as an output, reading the port bit actually reads the value of the data latch and not the voltage on the pin. When pin PD5 is programmed as an input, reading bit PD5 reads the voltage level on the pin. Bit PD5 can always be written, regardless of the state of bit DDRD5 in data direction register D. Table 7-4 summarizes the operation of the port D pins.

Table 7-4. Port D Pin Functions

DDRD Bit	PORTD Bit	I/O Pin Mode	Accesses to DDRD	Accesses to PORTD	
			Read/Write	Read	Write
0	Х	Input, hi-Z	DDRD5	Pin	NOTE 2
1	Х	Output	DDRD5	PD5	PD5

#### NOTES:

- X = don't care.
   Writing affects data register, but does not affect input.
- 3. Hi-Z = high impedance.

**MOTOROLA** 7-12

PARALLEL I/O

MC68HC705P6 REV. 1

# SECTION 8 CAPTURE/COMPARE TIMER

This section describes the operation of the 16-bit capture/compare timer. Figure 8-1 shows the organization of the capture/compare timer subsystem.

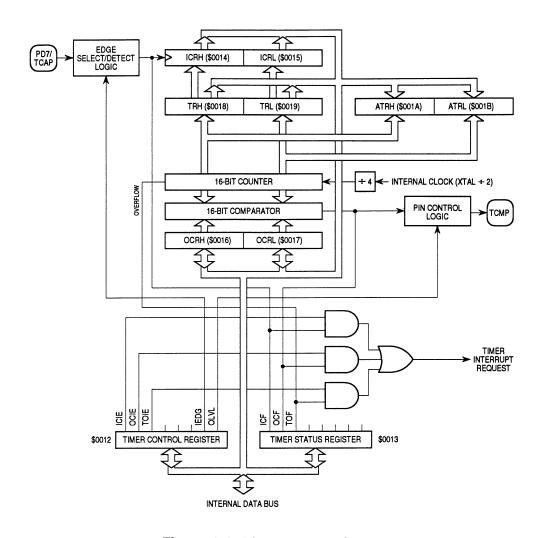


Figure 8-1. Timer Block Diagram

MC68HC705P6 REV. 1 CAPTURE/COMPARE TIMER

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### 8.1 Timer Operation

The core of the capture/compare timer is a 16-bit free-running counter. The counter is the timing reference for the input capture and output compare functions. The input capture and output compare functions provide a means to latch the times at which external events occur, to measure input waveforms, and to generate output waveforms and timing delays. Software can read the value in the 16-bit free-running counter at any time without affecting the counter sequence.

Because of the 16-bit timer architecture, the I/O registers for the input capture and output compare functions are pairs of 8-bit registers.

Because the counter is 16 bits long and preceded by a fixed divide-by-four prescaler, the counter rolls over every 262,144 internal clock cycles. Timer resolution with a 4-MHz crystal is 2  $\mu$ s.

### 8.1.1 Input Capture

The input capture function is a means to record the time at which an external event occurs. When the input capture circuitry detects an active edge on the PD7/TCAP pin, it latches the contents of the timer registers into the input capture registers. The polarity of the active edge is programmable.

Latching values into the input capture registers at successive edges of the same polarity measures the period of the input signal on the PD7/TCAP pin. Latching the counter values at successive edges of opposite polarity measures the pulse width of the signal. Figure 8-2 shows the logic of the input capture function.

MOTOROLA 8-2 CAPTURE/COMPARE TIMER

MC68HC705P6 REV. 1

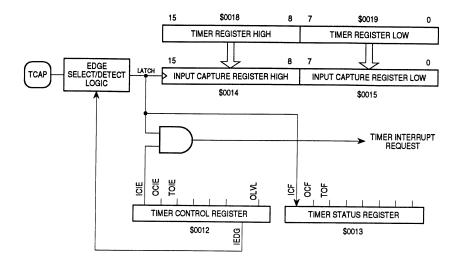


Figure 8-2. Input Capture Operation

#### 8.1.2 Output Compare

The output compare function is a means of generating an output signal when the 16-bit counter reaches a selected value. Software writes the selected value into the output compare registers. On every fourth internal clock cycle the output compare circuitry compares the value of the counter to the value written in the output compare registers. When a match occurs, the timer transfers the programmable output level bit (OLVL) from the timer control register to the TCMP pin.

Software can use the output compare register to measure time periods, to generate timing delays, or to generate a pulse of specific duration or a pulse train of specific frequency and duty cycle on the TCMP pin. Figure 8-3 shows the logic of the output compare function.

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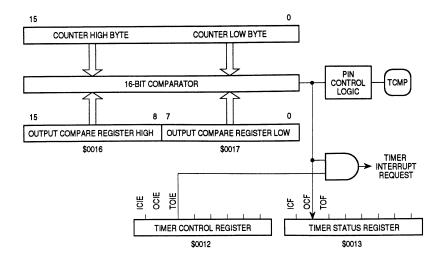


Figure 8-3. Output Compare Operation

### 8.2 Timer I/O Registers

The following registers control and monitor the operation of the timer:

- Timer control register (TCR)
- Timer status register (TSR)
- Timer registers (TRH and TRL)
- Alternate timer registers (ATRH and ATRL)
- Input capture registers (ICRH and ICRL)
- Output compare registers (OCRH and OCRL)

**MOTOROLA** 8-4

CAPTURE/COMPARE TIMER

MC68HC705P6

# 8.2.1 Timer Control Register (TCR)

The timer control register, shown in Figure 8-4, performs the following functions:

- Enables input capture interrupts
- Enables output compare interrupts
- · Enables timer overflow interrupts
- · Controls the active edge polarity of the TCAP signal
- Controls the active level of the TCMP output

### TCR — Timer Control Register

RESET:

\$0012

 Bit 7
 6
 5
 4
 3
 2
 1
 Bit 0

 ICIE
 OCIE
 TOIE
 0
 0
 0
 IEDG
 OLVL

 0
 0
 0
 0
 0
 U
 0

 U = UNAFFECTED

Figure 8-4. Timer Control Register (TCR)

#### ICIE — Input Capture Interrupt Enable

This read/write bit enables interrupts caused by an active signal on the TCAP pin. Resets clear the ICIE bit.

- 1 = Input capture interrupts enabled
- 0 = Input capture interrupts disabled

### OCIE — Output Compare Interrupt Enable

This read/write bit enables interrupts caused by an active signal on the TCMP pin. Resets clear the OCIE bit.

- 1 = Output compare interrupts enabled
- 0 = Output compare interrupts disabled

### TOIE — Timer Overflow Interrupt Enable

This read/write bit enables interrupts caused by a timer overflow. Resets clear the TOIE bit.

- 1 = Timer overflow interrupts enabled
- 0 = Timer overflow interrupts disabled

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#### IEDG — Input Edge

The state of this read/write bit determines whether a positive or negative transition on the TCAP pin triggers a transfer of the contents of the timer register to the input capture register. Resets have no effect on the IEDG bit.

- 1 = Positive edge (low to high transition) triggers input capture
- 0 = Negative edge (high to low transition) triggers input capture

#### OLVL — Output Level

The state of this read/write bit determines whether a logic one or a logic zero appears on the TCMP pin when a successful output compare occurs. Resets clear the OLVL bit.

- 1 = TCMP goes high on output compare
- 0 = TCMP goes low on output compare

#### 8.2.2 Timer Status Register (TSR)

The timer status register, shown in Figure 8-5, contains flags for the following events:

- An active signal on the TCAP pin, transferring the contents of the timer registers to the input capture registers
- A match between the 16-bit counter and the output compare registers, transferring the OLVL bit to the TCMP pin
- A timer rollover from \$FFFF to \$0000

### TSR — Timer Status Register

\$0012

**ICF** RESET: U

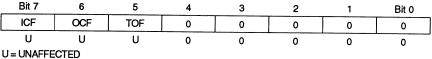


Figure 8-5. Timer Status Register (TSR)

#### ICF — Input Capture Flag

The ICF bit is automatically set when an edge of the selected polarity occurs on the TCAP pin. Clear the ICF bit by reading the timer status register with ICF set, and then reading the low byte (\$0015) of the input capture registers. Resets have no effect on ICF.

**MOTOROLA** 8-6

CAPTURE/COMPARE TIMER

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#### OCF — Output Compare Flag

The OCF bit is automatically set when the value of the timer registers matches the contents of the output compare registers. Clear the OCF bit by reading the timer status register with OCF set, and then accessing the low byte (\$0017) of the output compare registers. Resets have no effect on OCF.

### TOF — Timer Overflow Flag

The TOF bit is automatically set when the 16-bit counter rolls over from \$FFFF to \$0000. Clear the TOF bit by reading the timer status register with TOF set, and then accessing the low byte (\$0019) of the timer registers. Resets have no effect on TOF.

### 8.2.3 Timer Registers (TRH and TRL)

The timer registers, shown in Figure 8-6, contain the current high and low bytes of the 16-bit counter. Reading TRH before reading TRL causes TRL to be latched until TRL is read. Reading TRL after reading the timer status register clears the timer overflow flag (TOF). Writing to the timer registers has no effect.

#### TRH and TRL — Timer Register High/Low

\$0018 and \$0019

\$001	8
\$001	9

Bit 15	14	13	12	11	10	9	Bit 8
Bit 7	6	5	4	3	2	1	Bit 0

Reset initializes the timer registers to \$FFFC.

Figure 8-6. Timer Registers (TRH and TRL)

Reading TRH returns the current value of the high byte of the counter and causes the low byte to be latched into a buffer, as shown in Figure 8-7. The buffer value remains fixed even if the high byte is read more than once. Reading TRL reads the transparent low byte buffer and completes the read sequence of the timer registers.

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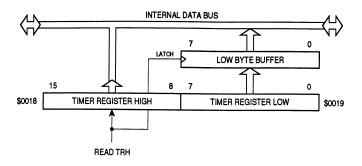


Figure 8-7. Timer Register Reads

#### NOTE

To prevent interrupts from occurring between readings of TRH and TRL, set the interrupt flag in the condition code register before reading TRH, and clear the flag after reading TRL.

### 8.2.4 Alternate Timer Registers (ATRH and ATRL)

The alternate timer registers, shown in Figure 8-8, contain the current high and low bytes of the 16-bit counter. Reading ATRH before reading ATRL causes ATRL to be latched until ATRL is read. Reading does not affect the timer overflow flag (TOF). Writing to the alternate timer registers has no effect.

### ATRH and ATRL — Alternate Timer Register High/Low

\$001A and \$001B

\$001A	Bit 15	14	13	12	11	10	9	Bit 8
\$001B	Bit 7	6	5	4	3	2	1	Bit 0
Reset initializes the alternate timer registers to \$FFFC.								

Figure 8-8. Alternate Timer Registers (ATRH and ATRL)

Reading ATRH returns the current value of the high byte of the counter and causes the low byte to be latched into a buffer, as shown in Figure 8-9. The buffer value remains fixed even if the high byte is read more than once. Reading ATRL reads the transparent low byte buffer and completes the read sequence of the alternate timer registers.

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CAPTURE/COMPARE TIMER

MC68HC705P6

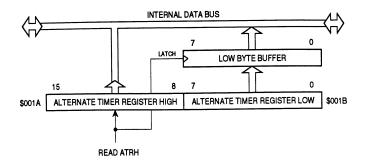


Figure 8-9. Alternate Timer Register Reads

#### NOTE

To prevent interrupts from occurring between readings of ATRH and ATRL, set the interrupt flag in the condition code register before reading ATRH, and clear the flag after reading ATRL.

# 8.2.5 Input Capture Registers (ICRH and ICRL)

When a selected edge occurs on the TCAP pin, the current high and low bytes of the 16-bit counter are latched into the input capture registers, as shown in Figure 8-10. Reading ICRH before reading ICRL inhibits further captures until ICRL is read. Reading ICRL after reading the timer status register clears the input capture flag (ICF). Writing to the input capture registers has no effect.

### ICRH and ICRL — Input Capture Register High/Low

\$0014 and \$0015

\$0014	
\$0015	

Bit 15	14	13	12	11	10	9	Bit 8
Bit 7	6	5	4	3	2	1	Bit 0

Reset does not affect the input capture registers.

Figure 8-10. Input Capture Registers (ICRH and ICRL)

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#### NOTE

To prevent interrupts from occurring between readings of ICRH and ICRL, set the interrupt flag in the condition code register before reading ICRH, and clear the flag after reading ICRL.

### 8.2.6 Output Compare Registers (OCRH and OCRL)

When the value of the 16-bit counter matches the value in the output compare registers, shown in Figure 8-11, the planned TCMP pin action takes place. Writing to OCRH before writing to OCRL inhibits timer compares until OCRL is written. Reading or writing to OCRL after reading the timer status register clears the output compare flag (OCF).

#### OCRH and OCRL — Output Compare Register High/Low

\$0016 and \$0017

\$0016	
\$0017	

Bit 15	14	13	12	11	10	9	Bit 8
Bit 7	6	5	4	3	2	1	Bit 0

Reset does not affect the output compare registers.

Figure 8-11. Output Compare Registers (OCRH and OCRL)

To prevent OCF from being set between the time it is read and the time the output compare registers are updated, use the following procedure:

- 1. Disable interrupts by setting the I bit in the condition code register.
- 2. Write to OCRH. Compares are now inhibited until OCRL is written.
- 3. Clear bit OCF by reading the timer status register (TSR).
- 4. Enable the output compare function by writing to OCRL.
- 5. Enable interrupts by clearing the I bit in the condition code register.

MOTOROLA 8-10

CAPTURE/COMPARE TIMER

MC68HC705P6

## SECTION 9 SERIAL I/O PORT (SIOP)

This section describes the operation of the serial I/O port (SIOP). Figure 9-1 shows the structure of the SIOP subsystem.

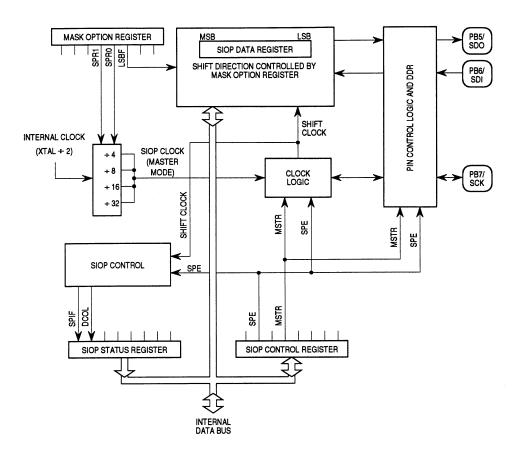


Figure 9-1. SIOP Block Diagram

MC68HC705P6 REV. 1 SERIAL I/O PORT (SIOP)

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#### 9.1 SIOP Operation

The SIOP enables high-speed synchronous serial data transmission between the MCU and peripheral devices. Shift registers used with the SIOP can increase the number of parallel I/O pins controlled by the MCU. More powerful peripherals such as analog-to-digital converters and real-time clocks are also compatible with the SIOP. A programmable option allows the SIOP to transmit data MSB-first or LSB-first.

#### 9.1.1 SIOP Pin Functions

The SIOP uses the three port B I/O pins. Setting the SPE bit in the SIOP control register enables the SIOP. When the SPE bit is set, the PB7/SCK, PB6/SDI, and PB5/SDO pins are dedicated to SIOP functions. When the SPE bit is clear, the PB7/SCK, PB6/SDI, and PB5/SDO pins are bidirectional port B I/O pins.

Setting the MSTR bit in the SIOP control register configures the SIOP for master mode. In master mode, the PB7/SCK pin is the serial clock output. PB6/SDI is the serial data input pin, and PB5/SDO is the serial data output pin. The master MCU initiates and controls the transmission of data to and from one or more slave peripheral devices. In master mode, a transmission is initiated by writing to the SIOP data register. Data written to the SIOP data register is parallel-loaded and shifted out serially to the slave device(s).

MOTOROLA 9-2 SERIAL I/O PORT (SIOP)

MC68HC705P6 REV. 1

For More Information On This Product, Go to: www.freescale.com

## 9.1.2 Serial Clock

The PB7/SCK pin synchronizes the movement of data into and out of the MCU through the PB6/SDI and PB5/SDO pins. In master mode, the PB7/SCK pin is an output. The transmission rate for master mode is programmable through the mask option register. (See 11.3 Mask Option Register (MOR).)

In slave mode, the PB7/SCK pin is an input. The maximum serial clock rate for slave mode is the maximum internal clock rate divided by four. There is no minimum serial clock frequency for slave mode.

Figure 9-2 shows the timing relationships between the serial clock, data input, and data output. The state of the serial clock between transmissions is a logic one. The first falling edge on the PB7/SCK pin signals the beginning of a transmission, and data appears at the PB5/SDO pin. Data is captured at the PB6/SDI pin on the rising edge of the serial clock, and the transmission ends on the eighth rising edge of the serial clock.

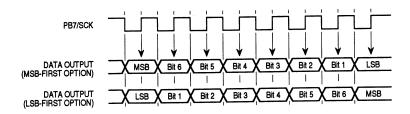


Figure 9-2. SIOP Data/Clock Timing

Valid serial data input (SDI) data must be present for an SDI setup time before the rising edge of the serial clock and must remain valid for an SDI hold time after the rising edge of the serial clock. (See 13.9 SIOP Timing ( $V_{DD} = 5.0$  Vdc) and 13.10 SIOP Timing ( $V_{DD} = 3.3$  Vdc).)

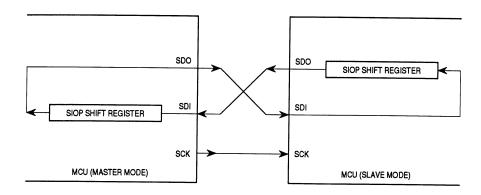
Between transmissions, the state of the PB5/SDO pin reflects the value of the last bit received on the previous transmission. On the first falling edge on the PB7/SCK pin, the first data bit to be shifted out appears at the PB5/SDO pin.

MC68HC705P6 REV. 1 SERIAL I/O PORT (SIOP)

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#### 9.1.3 Data Movement

Connecting the SIOP data register of a master MCU with the SIOP of a slave MCU forms a 16-bit circular shift register. During a SIOP transmission, the master shifts out the contents of its SIOP data register on its PB5/SDO pin. At the same time, the slave MCU shifts out the contents of its SIOP data register on its SDO pin. Figure 9-3 shows how the master and slave exchange the contents of their data registers.



NOTE: Both MCUs shown are programmed for MSB first data format.

Figure 9-3. Master/Slave SIOP Shift Register Operation

### 9.2 SIOP I/O Registers

The following registers control and monitor SIOP operation:

- SIOP control register (SCR)
- SIOP status register (SSR)
- SIOP data register (SDR)

## 9.2.1 SIOP Control Register (SCR)

The read/write SIOP control register, shown in Figure 9-4, contains two bits. One bit enables the SIOP, and the other configures the SIOP for master mode or for slave mode.

MOTOROLA 9-4

SERIAL I/O PORT (SIOP)

MC68HC705P6 REV. 1

## SCR — SIOP Control Register

\$000A

	Bit 7	6	5	4	3	2	1	Bit 0
	0	SPE	0	MSTR	0	0	0	0
RESET:	0	0	0	0	0	0	0	0

Figure 9-4. SIOP Control Register (SCR)

### SPE - SIOP Enable

This read/write bit enables the SIOP. Clearing the SPE bit during a transmission aborts the transmission and returns port B to its normal I/O function. After clearing the SPE bit, be sure to initialize the port B data direction register for the intended port B I/O use. Resets clear SPE.

- 1 = SIOP enabled
- 0 = SIOP disabled

## MSTR — Master Mode Select

This read/write bit configures the SIOP for master mode. Setting MSTR initializes the PB7/SCK pin as the serial clock output. Clearing MSTR initializes the PB7/SCK pin as the serial clock input. Resets clear MSTR.

- 1 = Master mode selected
- 0 = Slave mode selected

#### 9.2.2 SIOP Status Register (SSR)

The read/write SIOP status register, shown in Figure 9-5, contains two bits. One bit indicates that a SIOP transmission is complete, and the other indicates that an access of the SIOP data register occurred while a transmission was in progress.

#### SSR — SIOP Status Register

\$000B

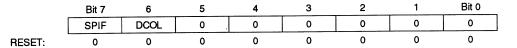


Figure 9-5. SIOP Status Register (SSR)

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#### SPIF — SIOP Interrupt Flag

This clearable, read-only bit is set automatically at the end of a transmission. Clear the SPIF bit by reading the SIOP status register with SPIF set, and then reading or writing the SIOP data register. Resets clear the SPIF bit.

- 1 = Serial transmission complete
- 0 = Serial transmission not complete

#### DCOL — Data Collision

This clearable, read-only bit is set if the SIOP data register is read or written during a transmission. Clear the DCOL bit by reading the SIOP status register with the SPIF bit set, and then reading or writing the SIOP data register. Resets clear the DCOL bit.

- 1 = Invalid access of SIOP data register
- 0 = No invalid access of SIOP data register

#### 9.2.3 SIOP Data Register (SDR)

The SIOP data register, shown in Figure 9-6, is both the transmit data register and the receive data register. To read or write the SIOP data register, the SPE bit in the SIOP control register must be set.

### SDR — SIOP Data Register

\$000C

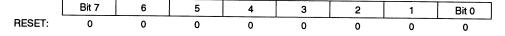


Figure 9-6. SIOP Data Register (SDR)

With the SIOP configured as master, writing to the SIOP data register initiates a serial transmission. This register is not buffered. Writing to the SIOP data register overwrites the previous contents. Reading or writing to the SIOP data register while a transmission is in progress can cause invalid data to be transmitted or received.

MOTOROLA 9-6 SERIAL I/O PORT (SIOP)

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IILV.

# SECTION 10 ANALOG-TO-DIGITAL CONVERTER (ADC)

This section describes the four-channel, 8-bit, successive approximation ADC.

## 10.1 ADC Operation

Figure 10-1 shows the structure of the ADC.

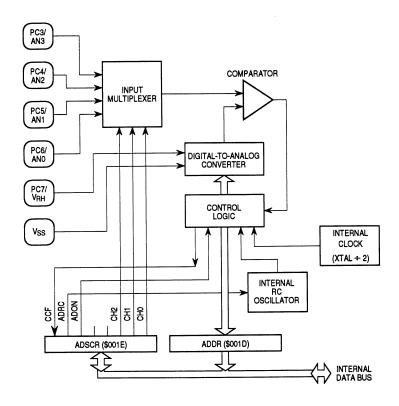


Figure 10-1. ADC Block Diagram

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A multiplexer selects one of four external analog signals for sampling. The CH2-CH0 bits in the ADC status and control register (ADSCR) control input selection.

A comparator makes successive comparisons of the selected analog input and the output of a precision digital-to-analog converter (DAC). Control logic changes the input to the DAC one bit at a time, starting with the MSB, until the DAC output matches the selected analog input. The conversion is monotonic and has no missing codes. At the end of 32 internal clock cycles, the conversion complete (CC) flag becomes set, and the digital conversion is readable in the ADC data register (ADDR).

For ratiometric conversion, the supply voltage of the analog source should be the same as  $V_{RH}$  and be referenced to  $V_{SS}$ . An analog input voltage equal to  $V_{RH}$  converts to digital \$FF; an input voltage greater than  $V_{RH}$  converts to \$FF with no overflow. An analog input voltage equal to  $V_{SS}$  converts to digital \$00.

#### 10.1.1 Pin Functions

Port C shares five of its pins with the ADC. The following paragraphs describe the ADC pin functions.

### 10.1.1.1 PC7/VRH

The PC7/ $V_{\rm RH}$  pin supplies the high reference voltage for the ratiometric conversion process. The low reference is connected internally to  $V_{\rm SS}$ .

## 10.1.1.2 PC6/AN0, PC5/AN1, PC4/AN2, and PC3/AN3

PC6/AN0, PC5/AN1, PC4/AN2, and PC3/AN3 are the analog inputs to the ADC.

## 10.1.2 Conversion Accuracy

Conversion accuracy of  $\pm 1.5$  LSB is guaranteed when  $V_{RH} = V_{DD}$ .

#### 10.1.3 Conversion Time

Each input conversion takes 32 internal clock cycles. The internal clock frequency must be equal to or greater than 1 MHz.

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ANALOG-TO-DIGITAL CONVERTER (ADC)

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#### 10.1.4 Internal RC Oscillator

If the internal clock frequency is less than 1 MHz, the internal RC oscillator must be used for the ADC clock instead of the internal clock. The nominal frequency of the RC oscillator is 1.5 MHz. Select the internal RC oscillator by setting the ADRC bit in the ADSCR.

Since the RC oscillator is not synchronous with the internal clock, software must rely on the CC bit to determine when each conversion process is complete.

Using the RC oscillator may slightly degrade ADC accuracy. The ADC reads voltages only during the periods when the clock driving it is not changing. But since the RC oscillator and the internal clock are not synchronous, the ADC occasionally reads voltages during internal clock transitions.

When the internal clock frequency is 1 MHz or greater, the RC oscillator must be turned off.

## 10.2 ADC I/O Registers

The following registers control and monitor operation of the ADC:

- ADC status and control register (ADSCR)
- ADC data register (ADDR)

## 10.2.1 ADC Status and Control Register (ADSCR)

The ADC status and control register, shown in Figure 10-2, contains a conversion complete flag and performs the following control functions:

- Turns on the ADC
- Turns on the internal RC oscillator
- · Selects the analog inputs

Writing to ADSCR clears the conversion complete flag and starts a new conversion sequence.

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#### ADSCR — ADC Status and Control Register

\$001E

	Bit 7	6	5	4	3	2	1	Bit 0
	$\infty$	ADRC	ADON	0	0	CH2	CH1	CH0
RESET:	0	0	0	0	0	0	0	0

Figure 10-2. ADC Status and Control Register (ADSCR)

#### CC — Conversion Complete

This read-only bit is automatically set at the end of each conversion process. When CC is set, the result of the conversion is readable in the ADDR. Clear the CC bit by writing to the CH2–CH0 bits or by clearing the ADON bit or by reading the ADDR. Resets clear CC.

- 1 = Conversion complete
- 0 = Conversion not complete

### ADRC — ADC RC (Oscillator)

This read/write bit turns on the internal RC oscillator to drive the ADC. If the internal clock frequency (f<sub>OP</sub>) is less than 1 MHz, ADRC must be set. When the RC oscillator is turned on, it requires a time, t<sub>ADRC</sub>, to stabilize, and results can be inaccurate during this time. Resets clear ADRC.

- 1 = Internal RC oscillator drives ADC
- 0 = Internal clock drives ADC

#### ADON - ADC On

This read/write bit turns on the ADC. When the ADC is on, it requires a time,  $t_{ADON}$ , for the current sources to stabilize. During this time, results can be inaccurate. Resets clear ADON.

- 1 = ADC turned on
- 0 = ADC turned off

#### Bits 4-2 — Not used

Bits 4-2 always read as logic zeros.

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CH2-CH0 - Channel 2-Channel 0

These read/write bits select one of eight ADC input channels as shown in Table 10-1. Channels 0-3 are the port C input pins, PC3/AN3, PC4/AN2, PC5/AN1, and PC6/AN0. Channels 4-6 can be used for reference measurements. Channel 7 is reserved for factory testing.

Table 10-1. ADC Input Channel Selection

CH[2:1:0]	Channel	Signal
000	0	AN0 Port C Bit 6
001	1	AN1 Port C Bit 5
010	2	AN2 Port C Bit 4
011	3	AN3 Port C Bit 3
100	4	V <sub>RH</sub> Port C Bit 7
101	5	(V <sub>RH</sub> + V <sub>SS</sub> ) ÷ 2
110	6	Vss
111	7	Reserved

To prevent excess power dissipation, do not use a port C pin as an analog input and a digital input at the same time.

Using one of the port C pins as the ADC input does not affect the ability to use the remaining port C pins as digital inputs.

Reading a port C pin that is selected as an analog input returns a logic zero.

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## 10.2.2 ADC Data Register (ADDR)

The ADC data register is a read-only register that contains the result of the most recent analog-to-digital conversion.



Figure 10-3. ADC Data Register (ADDR)

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ANALOG-TO-DIGITAL CONVERTER (ADC)

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### SECTION 11 EPROM/OTPROM

This section describes how to program the 4672-byte EPROM/OTPROM.

## 11.1 EPROM/OTPROM Programming

There are two ways to program the EPROM/OTPROM:

- Manipulating the control bits in the EPROM programming register to program the EPROM/OTPROM on a byte-by-byte basis.
- Activating the bootloader ROM to download the contents of an external memory device to the on-chip EPROM/OTPROM.

## 11.1.1 EPROM Programming Register (EPROG)

The EPROM programming register, shown in Figure 11-1, contains the control bits for programming the EPROM/OTPROM.

**EPROG** — EPROM Programming Register

\$001C

	Bit 7	6	5	4	3	2	1	Bit 0
	0	0	0	0	0	ELAT	MPGM	EPGM
RESET:	0	0	0	0	0	0	0	0

Figure 11-1. EPROM Programming Register (EPROG)

#### **ELAT** — EPROM Latch

This read/write bit latches data on the address bus and the data bus for EPROM/OTPROM programming. Clearing the ELAT bit automatically clears the EPGM bit. EPROM/OTPROM data cannot be read while the ELAT bit is set. Resets clear the ELAT bit.

- 1 = Address and data buses configured for EPROM/OTPROM programming
- 0 = Address and data buses configured for normal operation

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MPGM — Mask Option Register (MOR) Programming

This read/write bit applies the voltage from the  $\overline{IRQ}/V_{PP}$  pin to the MOR. Resets clear the MPGM bit.

- 1 = MOR programming power switched on
- 0 = MOR programming power switched off

## **EPGM** — **EPROM** Programming

This read/write bit applies the voltage from the  $\overline{IRQ}/V_{PP}$  pin to the EPROM/OTPROM. To write the EPGM bit, the ELAT bit must already be set. Clearing the ELAT bit also clears the EPGM bit. Resets clear the EPGM bit.

- 1 = EPROM/OTPROM programming power switched on
- 0 = EPROM/OTPROM programming power switched off

#### NOTE

Writing logic ones to both the ELAT and EPGM bits with a single instruction sets ELAT and clears EPGM. ELAT must be set first by a separate instruction.

#### Bits 7-3 — Reserved

Bits 7–3 are factory test bits that always read as logic zeros.

Take the following steps to program a byte of EPROM/OTPROM:

- 1. Apply 16.5 V to the IRQ/V<sub>PP</sub> pin.
- 2. Set the ELAT bit.
- 3. Write to any EPROM/OTPROM address.
- 4. Set the EPGM bit for a time, t<sub>EPGM</sub>, to apply the programming voltage.
- 5. Clear the ELAT bit.

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#### 11.1.2 Bootloader ROM

The bootloader ROM, located at addresses \$1F01-\$1FEF, contains routines for copying to the on-chip EPROM/OTPROM from an external EPROM.

The bootloader copies to the following MC68HC705P6 EPROM/OTPROM addresses:

- \$0020-\$004F
- \$0100-\$12FF
- \$1F00 (mask option register)
- \$1FF0-\$1FFF

The addresses of the code in the external EPROM must match the MC68HC705P6 addresses. The bootloader ignores all other addresses.

Figure 11-2 shows the circuit used to download to the on-chip EPROM/OTPROM from a 2764 EPROM. The bootloader circuit includes an external 12-bit counter to address the external EPROM. Operation is fastest when unused external EPROM addresses contain \$00. The bootloader function begins when a rising edge occurs on the  $\overline{\text{RESET}}$  pin while the  $\overline{\text{IRQ}}/\text{Vpp}$  pin is at 2 x VDD and the PD7/TCAP pin is at VDD.

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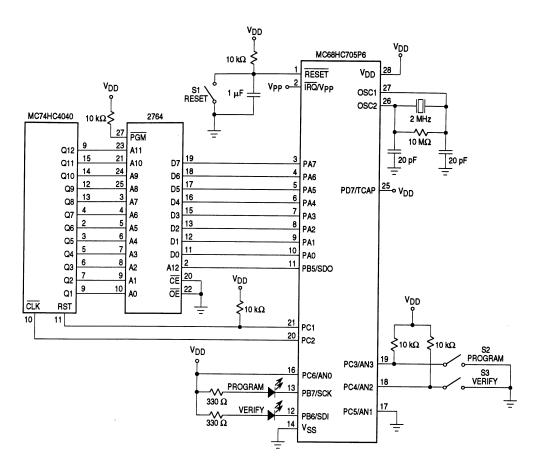


Figure 11-2. Bootloader Circuit

Complete the following steps to bootload the MCU:

- 1. Turn off all power to the circuit.
- 2. Install the EPROM containing the code to be downloaded.
- 3. Install the MCU.
- 4. Select the bootloader function:
  - a. Open switches S2 and S3 to select the program and verify function.
  - b. Open only switch S3 to select only the verify function.

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- 5. Close switch S1.
- 6. Turn on the V<sub>DD</sub> power supply.

#### CAUTION

Turn on the  $V_{DD}$  power supply **before** turning on the  $V_{PP}$  power supply. Damage to the MCU can occur if  $V_{PP}$  is turned on first.

- 7. Turn on the V<sub>PP</sub> power supply.
- 8. Open switch S1. The bootloader code begins to execute. If the program function is selected, the PROGRAM LED turns on during programming. If the verify function is selected, the VERIFY LED turns on when verification is successful. The program and verify function takes about 40 seconds.
- 9. Close switch S1.
- Turn off the V<sub>PP</sub> power supply.

#### CAUTION

Turn off the V<sub>PP</sub> power supply **before** turning off the V<sub>DD</sub> power supply. Damage to the MCU can occur if V<sub>DD</sub> is turned off first.

11. Turn off the V<sub>DD</sub> power supply.

#### 11.2 EPROM Erasing

The erased state of an EPROM bit is zero. Erase the EPROM by exposing it to 15 Ws/cm<sup>2</sup> of ultraviolet light with a wavelength of 2537 angstroms. Position the ultraviolet light source one inch from the EPROM. Do not use a shortwave filter.

Cerdip packages have a transparent window for erasing the EPROM with ultraviolet light. In the windowless PDIP and SOIC packages, the 4672 EPROM bytes function as one-time programmable ROM (OTPROM)

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#### 11.3 Mask Option Register (MOR)

The mask option register, shown in Figure 11-3, is an EPROM/OTPROM byte that controls the following options:

- Enabled or disabled STOP instruction
- SIOP clock rate
- MSB first or LSB first SIOP data transfer
- Edge-triggered or edge- and level-triggered external interrupt pin
- Enabled or disabled COP watchdog

#### MOR — Mask Option Register

\$1F00

	Bit 7	6	5	4	3	2	1	Bit 0
	1	1	SWAIT	SPR1	SPR0	LSBF	LEVEL	COPE
RESET:			t	JNAFFECTE	D BY RESET	•		
ERASED:	0	0	0	0	0	0	0	0

Figure 11-3. Mask Option Register (MOR)

Bits 7 and 6 — Unused

Program bits 7 and 6 to logic zero.

#### SWAIT — STOP Conversion to WAIT

The SWAIT bit disables the STOP instruction and prevents inadvertently turning off the COP watchdog with a STOP instruction. When the SWAIT bit is set, a STOP instruction puts the MCU in halt mode. Halt mode is a low-power mode similar to wait mode. The internal oscillator continues to run, but the CPU clock stops. When the SWAIT bit is clear, a STOP instruction stops the internal oscillator, the internal clock, and the CPU clock.

- 1 = STOP instruction puts MCU in halt mode
- 0 = STOP instruction puts MCU in stop mode

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SPR1, SPR0 — SIOP Rate

SPR1 and SPR0 select the SIOP clock rate, as shown in Table 11-1.

Table 11-1. SIOP Clock Rate Selection

SPR1:SPR0	SIOP Clock Rate
00	for Divided by 32
01	for Divided by 16
10	f <sub>OP</sub> Divided by 8
11	for Divided by 4

LSBF — Least Significant Bit First

LSBF controls the shift direction into and out of the SIOP shift register.

- 1 = SIOP data transferred LSB first
- 0 = SIOP data transferred MSB first

LEVEL — Level-Sensitive External Interrupt Trigger

The LEVEL bit makes the external interrupt function of the  $\overline{\text{IRQ}}/\text{V}_{PP}$  pin level-triggered as well as edge-triggered.

- 1 = IRQ/V<sub>PP</sub> pin negative edge-triggered and low level-triggered
- $0 = \overline{IRQ}/V_{PP}$  pin negative edge-triggered only

COPE — COP Watchdog Enable

COPE enables the COP watchdog. In applications that have wait cycles longer than the COP watchdog timeout period, the COP watchdog can be disabled by not programming the COPE bit to logic one.

- 1 = COP watchdog enabled
- 0 = COP watchdog disabled

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The STOP instruction turns off the COP watchdog. In applications that depend on the COP watchdog, the STOP instruction can be disabled by programming the SWAIT bit to logic one in the mask option register. Table 11-2 summarizes the recommended conditions for enabling the COP watchdog.

Table 11-2. COP Watchdog Recommendations

SWAIT Bit	Wait/Halt Time	Recommended COP Watchdog Condition
1	Less than COP Timeout Period	Enabled (COPE = 1)
1	Greater than COP Timeout Period	Disabled (COPE = 0)
0	X	Disabled (COPE = 0)

NOTE: X = don't care.

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# SECTION 12 INSTRUCTION SET

This section describes the addressing modes and the types of instructions.

## 12.1 Addressing Modes

The CPU uses eight addressing modes for flexibility in accessing data. These addressing modes define the manner in which the CPU finds the data required to execute an instruction. The eight addressing modes are as follows:

- Inherent
- Immediate
- Direct
- Extended
- · Indexed, no offset
- · Indexed, 8-bit offset
- Indexed, 16-bit offset
- Relative

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#### 12.1.1 Inherent

Inherent instructions are those that have no operand, such as return from interrupt (RTI) and stop (STOP). Some of the inherent instructions act on data in the CPU registers, such as set carry flag (SEC) and increment accumulator (INCA). Inherent instructions require no memory address and are one byte long. Table 12-1 lists the instructions that use inherent addressing.

Table 12-1. Inherent Addressing Instructions

Instruction	Mnemonic
Arithmetic Shift Left	ASLA, ASLX
Arithmetic Shift Right	ASRA, ASRX
Clear Carry Bit	CLC
Clear Interrupt Mask	CLI
Clear	CLRA, CLRX
Complement	COMA, COMX
Decrement	DECA, DECX
Increment	INCA, INCX
Logical Shift Left	LSLA, LSLX
Logical Shift Right	LSRA, LSRX
Multiply Index Register by Accumulator (Unsigned)	MUL
Negate	NEGA, NEGX
No Operation	NOP
Rotate Left through Carry	ROLA, ROLX
Rotate Right through Carry	RORA, RORX
Reset Stack Pointer	RSP
Return from Interrupt	RTI
Return from Subroutine	RTS
Set Carry Bit	SEC
Set Interrupt Mask	SEI
Enable IRQ and Stop Oscillator	STOP
Software Interrupt	SWI
Transfer Accumulator to Index Register	TAX
Test for Negative or Zero	TSTA, TSTX
Transfer Index Register to Accumulator	TXA
Enable Interrupts and Halt CPU	WAIT

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#### 12.1.2 Immediate

Immediate instructions are those that contain a value to be used in an operation with the value in the accumulator or index register. Immediate instructions require no memory address and are two bytes long. The opcode is the first byte and the immediate data value is the second byte. Table 12-2 lists the instructions that use immediate addressing.

Table 12-2. Immediate Addressing Instructions

Instruction	Mnemonic
Add Memory and Carry to Accumulator	ADC
Add Memory to Accumulator	ADD
Logical AND Memory with Accumulator	AND
Bit Test Memory with Accumulator (Logical Compare)	BIT
Arithmetic Compare Accumulator with Memory	CMP
Arithmetic Compare Index Register with Memory	CPX
Exclusive OR Memory with Accumulator	EOR
Load Accumulator from Memory	LDA
Load Index Register from Memory	LDX
Logical Inclusive OR Memory with Accumulator	ORA
Subtract Memory and Carry from Accumulator	SBC
Subtract Memory from Accumulator	SUB

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#### 12.1.3 Direct

Direct instructions can access any of the first 256 memory addresses with two bytes. The first byte is the opcode, and the second is the low byte of the operand address. In direct addressing, the CPU automatically uses \$00 as the high byte of the operand address. BRSET and BRCLR are three-byte instructions that use direct addressing to access the operand and relative addressing to specify a branch destination. Table 12-3 lists the instructions that use direct addressing.

Table 12-3. Direct Addressing Instructions

Instruction	Mnemonic
Add Memory and Carry to Accumulator	ADC
Add Memory to Accumulator	ADD
Logical AND Memory with Accumulator	AND
Arithmetic Shift Left	ASL
Arithmetic Shift Right	ASR
Clear Bit	BCLR
Bit Test Memory with Accumulator (Logical Compare)	BIT
Branch if Bit Clear	BRCLR
Branch if Bit Set	BRSET
Set Bit	BSET
Clear	CLR
Arithmetic Compare Accumulator with Memory	CMP
Complement	COM
Arithmetic Compare Index Register with Memory	CPX
Decrement	DEC
Exclusive OR Memory with Accumulator	EOR
Increment	INC
Jump	JMP
Jump to Subroutine	JSR
Load Accumulator from Memory	LDA
Load Index Register from Memory	LDX
Logical Shift Left	LSL
Logical Shift Right	LSR
Negate	NEG
Logical Inclusive OR Memory with Accumulator	ORA
Rotate Left through Carry	ROL
Rotate Right through Carry	ROR
Subtract Memory and Carry from Accumulator	SBC
Store Accumulator in Memory	STA
Store Index Register in Memory	STX
Subtract Memory from Accumulator	SUB
Test for Negative or Zero	TST

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#### 12.1.4 Extended

Extended instructions use only three bytes to access any address in memory. The first byte is the opcode; the second and third bytes are the high and low bytes of the operand address.

When using the Motorola assembler, the programmer does not need to specify whether an instruction is direct or extended. The assembler automatically selects the shortest form of the instruction. Table 12-4 lists the instructions that use extended addressing.

Table 12-4. Extended Addressing Instructions

Instruction	Mnemonic
Add Memory and Carry to Accumulator	ADC
Add Memory to Accumulator	ADD
Logical AND Memory with Accumulator	AND
Bit Test Memory with Accumulator (Logical Compare)	BIT
Arithmetic Compare Accumulator with Memory	CMP
Arithmetic Compare Index Register with Memory	CPX
Exclusive OR Memory with Accumulator	EOR
Jump	JMP
Jump to Subroutine	JSR
Load Accumulator from Memory	LDA
Load Index Register from Memory	LDX
Logical Inclusive OR Memory with Accumulator	ORA
Subtract Memory and Carry from Accumulator	SBC
Store Accumulator in Memory	STA
Store Index Register in Memory	STX
Subtract Memory from Accumulator	SUB

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### 12.1.5 Indexed, No Offset

Indexed instructions with no offset are one-byte instructions that can access data with variable addresses within the first 256 memory locations. The index register contains the low byte of the conditional address of the operand. The CPU automatically uses \$00 as the high byte, so these instructions can address locations \$0000–\$00FF.

Indexed, no offset instructions are often used to move a pointer through a table or to hold the address of a frequently used RAM or I/O location. Table 12-5 lists the instructions that use indexed, no offset addressing.

#### 12.1.6 Indexed, 8-Bit Offset

Indexed, 8-bit offset instructions are two-byte instructions that can access data with variable addresses within the first 511 memory locations. The CPU adds the unsigned byte in the index register to the unsigned byte following the opcode. The sum is the conditional address of the operand. These instructions can access locations \$0000–\$01FE.

Indexed, 8-bit offset instructions are useful for selecting the kth element in an n-element table. The table can begin anywhere within the first 256 memory locations and could extend as far as location 510 (\$01FE). The k value would typically be in the index register, and the address of the beginning of the table would be in the byte following the opcode. Table 12-5 lists the instructions that use indexed, 8-bit offset addressing.

#### 12.1.7 Indexed, 16-Bit Offset

Indexed, 16-bit offset instructions are three-byte instructions that can access data with variable addresses at any location in memory. The CPU adds the unsigned byte in the index register to the two unsigned bytes following the opcode. The sum is the conditional address of the operand. The first byte after the opcode is the high byte of the 16-bit offset; the second byte is the low byte of the offset. These instructions can address any location in memory.

Indexed, 16-bit offset instructions are useful for selecting the kth element in an n-element table anywhere in memory.

As with direct and extended addressing, the Motorola assembler determines the shortest form of indexed addressing. Table 12-5 lists the instructions that use indexed, 16-bit offset addressing.

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Table 12-5. Indexed Addressing Instructions

Instruction	Mnemonic	No Offset	8-Bit Offset	16-Bit Offset
Add Memory and Carry to Accumulator	ADC	1	7	1
Add Memory to Accumulator	ADD	1	√	1
Logical AND Memory with Accumulator	AND	1	1	1
Arithmetic Shift Left	ASL	1	1	
Arithmetic Shift Right	ASR	7	√	
Bit Test Memory with Accumulator (Logical Compare)	BIT	1	1	1
Clear	CLR	1	√	
Arithmetic Compare Accumulator with Memory	CMP	√	√	√
Complement	COM	√	√	
Arithmetic Compare Index Register with Memory	CPX	√	1	√
Decrement	DEC	1	1	
Exclusive OR Memory with Accumulator	EOR	√	√	√
Increment	INC	√	1	
Jump	JMP	√	1	1
Jump to Subroutine	JSR	√	1	1
Load Accumulator from Memory	LDA	√	1	1
Load Index Register from Memory	LDX	√	1	1
Logical Shift Left	LSL	√	1	
Logical Shift Right	LSR	√	√	
Negate	NEG	√	√	
Logical Inclusive OR Memory with Accumulator	ORA	√	√	1
Rotate Left through Carry	ROL	√	- √	
Rotate Right through Carry	ROR	√	1	
Subtract Memory and Carry from Accumulator	SBC	1	1	1
Store Accumulator in Memory	STA	1	√	√
Store Index Register in Memory	STX	1	√	√
Subtract Memory from Accumulator	SUB	1	1	√
Test for Negative or Zero	TST	√	1	

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#### 12.1.8 Relative

Relative addressing is only for branch instructions and bit test and branch instructions. If the branch condition is true, the CPU finds the conditional branch destination by adding the signed byte following the opcode to the contents of the program counter. If the branch condition is not true, the CPU goes to the next instruction. The offset is a signed, two's complement byte that gives a branching range of -128 to +127 bytes from the address of the next location after the branch instruction.

When using the Motorola assembler, the programmer does not need to calculate the offset, because the assembler determines the proper offset and verifies that it is within the span of the branch. Table 12-6 lists the instructions that use relative addressing.

Table 12-6. Relative Addressing Instructions

Instruction	Mnemonic
Branch if Carry Clear	BCC
Branch if Carry Set	BCS
Branch if Equal	BEQ
Branch if Half-Carry Clear	BHCC
Branch if Half-Carry Set	BHCS
Branch if Higher	BHI
Branch if Higher or Same	BHS
Branch if Interrupt Line High	BIH
Branch if Interrupt Line Low	BIL
Branch if Lower	BLO
Branch if Lower or Same	BLS
Branch if Interrupt Mask Clear	BMC
Branch if Minus	ВМІ
Branch if Interrupt Mask Set	BMS
Branch if Not Equal	BNE
Branch if Plus	BPL
Branch Always	BRA
Branch if Bit Clear	BRCLR
Branch if Bit Set	BRSET
Branch Never	BRN
Branch to Subroutine	BSR

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## 12.2 Instruction Types

The MCU instructions fall into the following five categories:

- Register/memory
- · Read-modify-write
- Jump/branch
- Bit manipulation
- Control

## 12.2.1 Register/Memory Instructions

Most of these instructions use two operands. One operand is in either the accumulator or the index register. The CPU finds the other operand in memory. Register/memory instructions use all the addressing modes except relative.

Table 12-7 lists the register/memory instructions.

Table 12-7. Register/Memory Instructions

Instruction	Mnemonic
Add Memory and Carry to Accumulator	ADC
Add Memory to Accumulator	ADD
Logical AND Memory with Accumulator	AND
Bit Test Memory with Accumulator (Logical Compare)	BIT
Arithmetic Compare Accumulator with Memory	CMP
Arithmetic Compare Index Register with Memory	CPX
Logical Exclusive OR Memory with Accumulator	EOR
Load Accumulator from Memory	LDA
Load Index Register from Memory	LDX
Multiply Index Register by Accumulator (Unsigned)	MUL
Logical Inclusive OR Memory with Accumulator	ORA
Subtract Memory and Carry from Accumulator	SBC
Store Accumulator in Memory	STA
Store Index Register in Memory	STX
Subtract Memory from Accumulator	SUB

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#### 12.2.2 Read-Modify-Write Instructions

These instructions read a memory location or a register, modify its contents, and write the modified value back to the memory location or to the register. The test for negative or zero (TST) instruction is an exception to the read-modify-write sequence because it does not write a replacement value. Read-modify-write instructions use the following addressing modes:

- Inherent
- Direct
- Indexed, no offset
- Indexed, 8-bit offset

Table 12-8 lists the read-modify-write instructions.

Table 12-8. Read-Modify-Write Instructions

Instruction	Mnemonic
Arithmetic Shift Left (Same as LSL)	ASL
Arithmetic Shift Right	ASR
Clear Bit in Memory	BCLR
Set Bit in Memory	BSET
Clear	CLR
Complement	COM
Decrement	DEC
Increment	INC
Logical Shift Left (Same as ASL)	LSL
Logical Shift Right	LSR
Negate (Two's Complement)	NEG
Rotate Left through Carry	ROL
Rotate Right through Carry	ROR
Test for Negative or Zero	TST

#### 12.2.3 Jump/Branch Instructions

Jump instructions allow the CPU to interrupt the normal sequence of the program counter. The unconditional jump (JMP) and jump to subroutine (JSR) instructions have no register operand. Jump instructions use the following addressing modes:

- Direct
- Extended

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- Indexed, no offset
- Indexed, 8-bit offset
- Indexed, 16-bit offset

Branch instructions allow the CPU to interrupt the normal sequence of the program counter when a test condition is met. If the test condition is not met, the branch is not performed. All branch instructions use relative addressing.

Bit test and branch instructions cause a branch based on the state of any readable bit in the first 256 memory locations. These three-byte instructions use a combination of direct addressing and relative addressing. The direct address of the byte to be tested is in the byte following the opcode. The third byte is the signed offset byte. The CPU finds the conditional branch destination by adding the third byte to the program counter if the specified bit tests true. The bit to be tested and its condition (set or clear) is part of the opcode. The span of branching is from -128 to +127 from the address of the next location after the branch instruction. The CPU also transfers the tested bit to the carry/borrow bit of the condition code register. Table 12-9 lists the jump and branch instructions.

Table 12-9. Jump and Branch Instructions

Instruction	Mnemonic
Branch if Carry Clear	BCC
Branch if Carry Set (Same as BLO)	BCS
Branch if Equal	BEQ
Branch if Half-Carry Bit Clear	BHCC
Branch if Half-Carry Bit Set	BHCS
Branch if Higher	BHI
Branch if Higher or Same	BHS
Branch if Interrupt Line High	BIH
Branch if Interrupt Line Low	BIL
Branch if Lower (Same as BCS)	BLO
Branch if Lower or Same	BLS
Branch if Interrupt Mask Clear	BMC
Branch if Minus	ВМІ
Branch if Interrupt Mask Set	BMS
Branch if Not Equal	BNE
Branch if Plus	BPL
Branch Always	BRA
Branch if Bit Clear	BRCLR
Branch Never	BRN
Branch if Bit Set	BRSET
Branch to Subroutine	BSR
Jump	JMP
Jump to Subroutine	JSR

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### 12.2.4 Bit Manipulation Instructions

The CPU can set or clear any writable bit in the first 256 bytes of memory. Port registers, port data direction registers, timer registers, and on-chip RAM locations are in the first 256 bytes of memory. The CPU can also test and branch based on the state of any bit in any of the first 256 memory locations. Bit manipulation instructions use direct addressing. Table 12-10 lists these instructions.

Table 12-10. Bit Manipulation Instructions

Instruction	Mnemonic
Clear Bit	BCLR
Branch if Bit Clear	BRCLR
Branch if Bit Set	BRSET
Set Bit	BSET

## 12.2.5 Control Instructions

These register reference instructions control CPU operation during program execution. Control instructions, listed in Table 12-11, use inherent addressing.

Table 12-11. Control Instructions

Instruction	Mnemonic
Clear Carry Bit	CLC
Clear Interrupt Mask	CLI
No Operation	NOP
Reset Stack Pointer	RSP
Return from Interrupt	RTI
Return from Subroutine	RTS
Set Carry Bit	SEC
Set Interrupt Mask	SEI
Stop	STOP
Software Interrupt	SWI
Transfer Accumulator to Index Register	TAX
Transfer Index Register to Accumulator	TXA
Wait	WAIT

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## 12.3 Instruction Set Summary

Table 12-12 shows all MC68HC705P9 instructions in all possible addressing modes. The table shows the operand construction and the execution time in internal clock cycles (tcyc) of each instruction. One internal clock cycle equals two oscillator input cycles. The following legend summarizes the symbols and abbreviations used in Table 12-12.

## **Abbreviations and Symbols**

Α	Accumulator	PCH	Program counter high byte
С	Carry/borrow flag	PCL	Program counter low byte
CCR	Condition code register	REL	Relative addressing
dd	Address of operand in direct addressing	rel	Offset byte for relative addressing
dd rr	Address (dd) of operand and offset (rr) of branch instruction for bit test instructions	rr	Offset byte of branch instruction
DIR	Direct addressing	SP	Stack pointer
ee ff	High (ee) and low (ff) bytes of offset in indexed, 16-bit offset addressing	X	Index register
EXT	Extended addressing	Z	Zero flag
ff	Offset byte in indexed, 8-bit offset addressing	•	AND
Н	Half-carry flag	-	Not affected
hh II	High (hh) and low (II) bytes of operand address in extended addressing	?	If
ı	Interrupt mask		NOT
ii	Operand byte for immediate addressing	()	Contents of
IMM	Immediate addressing	←	Is loaded with
INH	Inherent addressing	:	Concatenated with
IX	Indexed, no offset addressing	×	Multiplication
IX1	Indexed, 8-bit offset addressing	<b>-(</b> )	Negation (two's complement)
IX2	Indexed, 16-bit offset addressing	+	Inclusive OR
M	Any memory location (1 byte)	<b>\$</b>	Set if true; clear if not true
N	Negative flag	<b>⊕</b>	Exclusive OR
n	Any bit (7,6,5 0)	+	Addition
opr	Operand byte		Subtraction
PC	Program counter		

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Table 12-12. Instruction Set (Sheet 1 of 4)

Source			Addressing	Machin	Machine Coding		Γ		ondi	tion	
Form	Operation	Description	Mode for	(hexad	(hexadecimal)		1		Cod		
			Operand	Opcode	Operand	1	H	TT	N	Z	Tc
ADC #opr	Add with carry	A ← (A) + (M) + C	IMM	A9	li .	2	1	1-	\$	\$	1
ADC opr	l		DIR	B9	dd	3	1	1			1
ADC opr			EXT	C9	hh II	4	ı	1	1	l	
ADC opr,X		J	IX2	D9	ee ff	5	1	1		1	1
ADC opr,X			IX1	E9	ff	4		1			
ADC ,X			IX	F9		3	ĺ	İ	1	l	
ADD #opr	Add without carry	A ← (A) + (M)	IMM	AB	II	2	\$	T-	\$	\$	1
ADD opr			DIR	BB	dd	3	1				ı
ADD opr			EXT	СВ	hh II	4	i	1	1		1
ADD opr,X			IX2	DB	ee ff	5	1		1		1
ADD opr,X			IX1	EB	ff	4	1	1	1	1	l
ADD ,X			IX	FB		3	İ	I	l		L
AND #opr	Logical AND	$A \leftarrow (A) \bullet (M)$	IMM	A4	ii	2	-	Τ-	1	\$	-
AND opr			DIR	B4	dd	3	1	1			
AND opr			EXT	C4	hh II	4		1	1		
AND opr,X			IX2	D4	ee ff	5	l	1			1
AND opr,X			IX1	E4	1f	4	ļ				1
AND,X			IX	F4	1	3	1	1	İ	1	1
ASL opr	Arithmetic shift left (Same as		DIR	38	dd	5	-	Ι-	\$	\$	\$
ASLA	LSL)		INH	48		3	l				
ASLX		© <b>⊬</b> -□□□□□ <b>/</b> -0	INH	58		3	1		l		
ASL opr,X	i		IX1	68	ff	6	l	l	1		1
ASL opr,X			lx	78		5	Į.	l			
ASR opr	Arithmetic shift right		DIR	37	dd	5	<del> </del>	-	\$	1	\$
ASRA			INH	47		3	ı	1	1	ľ	ľ
ASRX		<del>'}                                      </del>	INH	57		3		ı			
ASR opr,X			IX1	67	11	6	1	1		ŀ	
ASR opr,X	l		lx	77		5	1	ŀ			
BCC rel	Branch if carry bit clear	?C=0	REL	24	rr	3	-	t =	-	_	1
BCLR n opr	Clear bit n	Mn ← 0	DIR (b0)	11	dd	5	-	l =	-	_	1
			DIR (b1)	13	dd	5					
			DIR (b2)	15	dd	5					
			DIR (b3)	17	dd	5			1		
		İ	DIR (b4)	19	dd	5					
			DIR (b5)	1B	dd	5					
			DIR (b6)	1D	dd	5					
			DIR (67)	1F	dd	5			. 1		
BCS rel	Branch if carry bit set (Same as	?C=1	REL	25	rr	3	-	-	-	_	-
	BLO)				l"	•			_		-
BEQ rel	Branch if equal	? Z = 1	REL	27	rr	3	-	-	-	_	-
BHCC rel	Branch if half carry bit clear	?H=0	REL	28	rr	3	_	_	-	-	_
BHCS rel	Branch if half carry bit set	?H=1	REL	29	rr	3	_	-	-1	-	_
BHI rel	Branch if higher	?C+Z=0	REL	22	rr	3	_		_	_	_
BHS rel	Branch if higher or same	?C=0	REL	24	rr	3	_		_	_	_
BIH rel	Branch if IRQ pin high	? ÎRQ = 1	REL	2F	rr	3	-	$\exists$	_	_	_
BIL rel	Branch if IRQ pin low	? IRQ = 0	REL	2E	rr	3	_		_	_	
BIT rel	Bit test accumulator with memory	(A) • (M)	IMM	A5	ii l	2	_	<del>-</del>	_	_	
	Di todi decamatator with memory	(/-) - (W)	DIR	B5	dd		-	-	\$	\$	-
						3				- 1	- 1
			EXT	C5	hh II	4			-	- 1	
			IX2 IX1	D5	ee 11	5	- 1	, [	- 1	Į	- 1
			IX I		ff	4	- 1	. 1			- 1
	Branch if lower (Same as BCS)	?C=1		F5		3	_	_			_
BLO rel		: - 1	REL		rr	3	ᆜ	ᆜ	-	ᆜ	ᅴ
		20-17 1	DEL								
BLS rel	Branch if lower or same	?C+Z=1	REL		rr	3	긔	_	-	-1	_
BLS rel BMC rel	Branch if lower or same Branch if interrupt mask clear	? I = 0	REL	2C	rr	3	크		=	=	Ξ
BLS rel BMC rel BMI rel	Branch if lower or same Branch if interrupt mask clear Branch if minus	? I = 0 ? N = 1	REL REL	2C 2B	rr rr	3	<u>-</u>	- - -	=	=	$\equiv$
BLO rel BLS rel BMC rel BMI rel BMS rel	Branch if lower or same Branch if interrupt mask clear Branch if minus Branch if interrupt mask set	? I = 0 ? N = 1 ? I = 0	REL REL	2C 2B 2D	rr rr	3 3 3		- - -		- - -	Ξ
BLS rel BMC rel BMI rel	Branch if lower or same Branch if interrupt mask clear Branch if minus	? I = 0 ? N = 1	REL REL	2C 2B 2D 26	rr rr	3	= = = = = = = = = = = = = = = = = = = =	- - - -	= = = = = = = = = = = = = = = = = = = =	- - - -	Ξ

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Table 12-12. Instruction Set (Sheet 2 of 4)

Source Form(s)	Operation	Description	Addressing Mode for	Machine (hexad	Cycles	Condition Code					
Form(8)	Operation	. Decemporary	Operand	Opcode	Operand		Н	1	N	Z	С
BRA rel	Branch always	?1=1	REL	20	rr	3	-	-	-	-	-
	Dianon annays	? Mn = 0	DIR (b0)	01	dd rr	5	-	-	-	-	\$
BHCLR II OPI TEI	Branchir bit ii deal		DIR (b1)	03	dd rr	5			1 1		
			DIR (b2)	05	dd rr	5	l I				
	· ·		DIR (b3)	07	dd rr	5			1 1		1
			DIR (b4)	09	dd rr	5					1 1
			DIR (b5)	0B	dd rr	5	l				1
			DIR (b6)	0D	dd rr	5					1
			DIR (b7)	0F	dd rr	5					
BRN rel	Branch never	?1=0	REL	21	rr	3	-	-	-	-	-
	Branch if bit n set	? Mn = 1	DIR (b0)	00	dd rr	5	-	-	-	-	\$
BHSE! II OPI TEI	Dialici ii Dii ii Sol		DIR (b1)	02	dd rr	5		i			
			DIR (b2)	04	dd rr	5		ŀ			il
	İ		DIR (b3)	06	dd rr	5		ŀ	'		
			DIR (b4)	08	dd rr	5		l	1		ll
	1		DIR (b5)	OA.	dd rr	5		l			
			DIR(b6)	oc	dd rr	5	İ	1			
			DIR (b7)	0E	dd rr	5	١		1		
DOET	Set bit n	Mn ← 1	DIR (b0)	10	dd	5	-	-	-	-	-
BSET n opr	Set bit n		DIR (b1)	12	dd	5				l	1 1
			DIR (b2)	14	dd	5	1		1	1	
	<u> </u>		DIR (b3)	16	dd	5	1	ļ	1		
			DIR (b4)	18	dd	5	1	ļ	1	i	!
	1		DIR (b5)	1A	dd	5		1	i	1	
	İ		DIR (b6)	1C	dd	5		l		1	
	1		DIR (67)	1E	dd	5		l		l	
		DC ( /DC) ( 2: puch /DCI )	REL	AD	rr	6	+_	-	+-	-	-
BSR rel	Branch to subroutine	$PC \leftarrow (PC) + 2$ ; push (PCL) $SP \leftarrow (SP) - 1$ ; push (PCH) $SP \leftarrow (SP) - 1$ $PC \leftarrow (PC) + rel$	HEL	AD	, , , , , , , , , , , , , , , , , , ,						
CLC	Clear carry bit	C ← 0	INH	98		2	-	_	<u> </u>	-	0
CLI	Clear interrupt mask	1←0	INH	9A		2	<b>-</b>	0	-	-	-
CLR opr	Clear register	M ← \$00	DIR	3F	dd	5	Γ-	T -	0	1	-
CLRA	Clour regions.	A ← \$00	INH	4F		3	1	İ	1	ı	
CLRX	1	X ← \$00 M ← \$00	INH	5F	i	3	1	1	1	1	1
CLR opr.X	1	M ← \$00	IX1	6F	11	6		1		ı	
CLR opr,X	1		ix	7F		5			<u> </u>		
CMP #opr	Compare accumulator with	(A) - (M)	IMM	A1	ii	2	T -	-	1	1	1
CMP opr	memory	[ V V V V V V V V V V V V V V V V V V V	DIR	B1	dd	3	1		1		1
CMP opr			EXT	C1	hh II	4	1				
CMP opr,X	•		IX2	D1	ee ff	5				1	1
CMP opr,X	1		IX1	E1	ff	4	1	1	1	1	1
CMP ,X		1	lix	F1	1	3		1	1		1
COM opr	Complement memory or	$M \leftarrow \overline{M} = \$FF - (M)$	DIR	33	dd	5	T-	T -	1	1	1
	register	$A \leftarrow \overline{A} = \$FF - (A)$	INH	43	1	3		1		1	1
COMA	(one's complement)	$X \leftarrow \overline{X} = \$FF - (X)$	INH	53	İ	3	1	1		1	
1		$M \leftarrow \overline{M} = \$FF - (M)$ $M \leftarrow \overline{M} = \$FF - (M)$	IX1	63	ltt .	6			1		
COM opr,X		W - W - W   (w)	ix	73	Į.	5	1	1			1
COM ,X	Compare index register	(X) - (M)	IMM	A3	ii	2	1-	T-	\$	1	1
CPX #opr	with memory	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	DIR	В3	dd	3	1	1	1		
CPX opr		1	EXT	C3	hh II	4		1			1
CPX opr			IX2	D3	ee ff	5	1		1		1
CPX opr,X			IX1	E3	ff	4	1	1			1
CPX opr,X			ix	F3	1	3	1		1		1
CPX ,X	Brances	M ← (M) − 1	DIR	3A	dd	5	1-	1-	1	1	1-
DEC opr	Decrement	A ← (A) − 1 X ← (X) − 1	INH	4A	1	3	1		1	1	
DECA	1.	$1 \times (x) = 1$		1	1	3	1	1	1		1
1	1	133 88 2	INH	j 5Δ					- 1		
DECX DEC opr,X		M ←(M) − 1 M ←(M) − 1	INH IX1	5A 6A	11	6	ĺ	1		Ì	

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Table 12-12. Instruction Set (Sheet 3 of 4)

Source Form(s)	Operation	Description	Addressing Mode for		Machine Coding (hexadecimal)				ondi Cod		
		1	Operand	Opcode	Operand		Н		N	Z	С
EOR #opr	Exclusive OR accumulator	A ← (A) ⊕ (M)	IMM	A8	ii	2	1-	-	1	\$	1-
EOR opr	with memory		DIR	B8	dd	3	1	i	`	1	
EOR opr		1	EXT	C8	hh II	4		l		l	
EOR opr,X		1	IX2	D8	ee ff	5	1	l		1	1
EOR opr,X			IX1	E8	ff	4	1	l			
EOR,X		1	IX .	F8		3	1	İ	1	1	
INC opr	Increment memory or register	M ← (M) + 1	DIR	3C	dd	5	Ι-	Ι-	\$	\$	1-1
INCA		A ← (A) + 1	INH	4C	1	3		l	ľ	ľ	1 1
INCX	1	X ← (X) + 1	INH	5C	l i	3		1			
INC opr,X	ĺ	M ← (M) + 1	IX1	6C	ff I	6	ı	1	1		
INC ,X		M ← (M) + 1	lx	7C		5	1	l			
JMP opr	Unconditional jump	PC ← jump address	DIR	BC	dd	2	-	Ι-	Ι_	-	
JMP opr			EXT	CC	hh II	3				1	
JMP opr,X			IX2	DC	ee ff	4		l			1 1
JMP opr,X			IX1	EC	111	3	l	ļ			1 1
JMP ,X		ĺ	lx	FC		2	l	1			H
JSR opr	Jump to subroutine	$PC \leftarrow (PC) + n (n = 1, 2, or 3)$	DIR	BD	dd	5	-	<del> </del>	-	Ι=	-
JSR opr		Push (PCL); SP ← (SP) – 1 Push (PCH); SP ← (SP) – 1	EXT	CD	hh II	6					
JSR opr,X		Pusn (PCH); SP ← (SP) = 1 PC ← conditional address	IX2	DD	ee ff	7					i i
JSR opr,X			IX1	ED	ff	6					
JSR ,X			ix	FD		5					
LDA #opr	Load accumulator from	A ← (M)	IMM	A6	ii	2	-	$\vdash$	\$	\$	닏
LDA opr	memory		DIR	B6	dd	3			*	*	i <sup>-</sup> I
LDA opr			EXT	C6	hh II	4					1 1
LDA opr,X			IX2	D6	ee ff	5	l				ıl
LDA opr,X			IX1	E6	11	4	1				1 1
LDA,X			ix	F6	l" l	3					ıI
LDX #opr	Load index register from	X ← (M)	IMM	AE	ii	2	$\vdash$	_	\$	\$	늰
LDA opr	memory		DIR	BE	dd	3			*	*	-
LDA opr			EXT	CE	hh II	4					
LDA opr.X			IX2	DE	ee ff	5					
LDA opr,X			IX1	EE	11	4					
LDA,X			ix	FE	l'' l	3					
LSL opr	Logical shift left (Same as		DIR	38	dd	5	_	$\dashv$	•	•	
LSLA	ASĽ)	<del></del>	INH	48	ا	3	-	-	<b>‡</b>	\$	\$
LSLX		©+ <u>;;;;;;;</u> ,,,,,	INH	58		3	1				
LSL opr,X		ω ω	IX1	68	ff	6			- 1		
LSLX			ix	78	"	5					. 1
LSR opr	Logical shift right		DIR	34	dd	5	-	-	0	_	_
LSRA	3	<del></del>	INH	44		3	-	-	١٠	\$	<b>‡</b>
LSRX		o⊷يـــــــينبو⊷	INH	54		3		ı	I		
LSR opr.X		0/ 60	IX1	64	11	6					
LSR X			ix	74	.	5	-	I	ļ		
MUL	Unsigned multiply	$X: A \leftarrow (X) \times (A)$	INH	42		11	7	_		$\dashv$	ᅱ
	Negate memory or register	$M \leftarrow -(M) = \$00 - (M)$	DIR	30	dd	5	<u> </u>	-	-	-	0
	(two's complement)	$A \leftarrow -(A) = \$00 - (A)$	INH	40	uu		-	-	<b>‡</b>	\$	<b>\$</b>
NEGX		$X \leftarrow -(X) = \$00 - (X)$	INH	50		3	- 1			ı	
NEG opr,X			IX1		ff	3					
NEG X		$M \leftarrow -(M) = $00 - (M)$ $M \leftarrow -(M) = $00 - (M)$	ix	70	"	6 5		1		-	
	No operation	$m \leftarrow -(m) = \phi \cup 0 - (m)$	INH	9D		2		-	4	_	_
		$A \leftarrow (A) + (M)$					긔	긔	-1	=1	_
	memory	, , , , , , , , , , , , , , , , , ,	IMM DIR		ii	2	- [	-	\$	\$	-
ORA opr			EXT		dd	3	- 1		- 1		- 1
ORA opr,X					hh II	4		- 1	-		
ORA opr,X			IX2		ee ff	5			- 1	- [	
ORA,X		i i i i i i i i i i i i i i i i i i i	IX1		ff	4	- 1		- 1	- 1	
	Rotate left through carry		IX	FA		3	_		_		_
ROLA	ion unough carry		DIR		dd	5	-	-	\$	<b>‡</b>	<b>‡</b>
ROLX		4CK4	INH	49	1	3	- 1	- 1		- 1	
ROL opr,X			INH	59		3	- 1			- 1	
ROL X			IX1		ff	6	- [	- 1			
1			IX	79		5			$\perp$		

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Table 12-12. Instruction Set (Sheet 4 of 4)

Source			Addressing		Coding				nditi		
Form	Operation	Description	Mode for		ecimal)	Cycles	L		ode		
	·		Operand	Opcode	Operand		н	1	N	Z	С
ROR opr	Rotate right through carry		DIR	36	dd	5	-	-	\$	\$	\$
RORA	,		INH	46		3					
RORX		القرائب الأسالية ا	INH	56		3					
ROR opr.X		B, 55	IX1	66	ff	6					
ROR ,X			ıx	76		5					
	D t . t l . m sinter	SP ← \$00FF	INH	9C		2	_	-	_	-	-
RSP	Reset stack pointer	SP ← (SP) + 1; pull (CCR)	INH	80		9		Fro	m St	ack	
RTI	Return from interrupt	SP ← (SP) + 1; pull (A)		""			ı	1	\$	1	1
		SP ← (SP) + 1; pull (X)					•	*	•	•	ľ
		SP ← (SP) + 1; pull (PCH)									ĺ
		$SP \leftarrow (SP) + 1$ ; pull (PCL)					_	ш			<b>—</b>
RTS	Return from subroutine	$SP \leftarrow (SP) + 1$ ; pull (PCH) $SP \leftarrow (SP) + 1$ ; pull (PCL)	INH	81		6	-	-	_	_	_
SBC #opr	Subtract memory and carry	$A \leftarrow (A) - (M) - C$	IMM	A2	ii	2	-	-	<b>\$</b>	\$	1
SBC opr	bit from accumulator		DIR	B2	dd	3					ı
SBC opr			EXT	C2	hh II	4					i
SBC opr,X			IX2	D2	ee ff	5					ı
SBC opr,X			lıxı	E2	ff	4	l				i
	i		ıx	F2		3			ŀ		ĺ
SBC ,X	0.1	C←1	INH	99		2	<u>†</u> -	-	-	_	1
SEC	Set carry bit	I←1	INH	9B	<del> </del>	2	<u> </u>	1	-	-	-
SEI	Set interrupt mask			B7	dd	4		<u> </u>	1	\$	┢
STA opr	Store accumulator in memory	M ← (A)	DIR	l l	hh II	5	-	_	•	•	
STA opr			EXT	C7	1		1				
STA opr,X			IX2	D7	ee ff	6			Ì		ĺ
STA opr,X			IX1	E7	ff	5	1				ĺ
STA ,X			IX	F7		4	ـــــ	<u> </u>	_		┞
STOP	Enable IRQ; stop oscillator		INH	8E		2	_	0	-	_	二
STX opr	Store index register in	M ← (X)	DIR	BF	dd	4	-	-	<b>‡</b>	\$	-
STX opr	memory		EXT	CF	hh II	5	1				1
STX opr,X			IX2	DF	ee ff	6	1		1	1	ĺ
STX opr,X			IX1	EF	ff	5	1	l			
STX JDI,X			lix	FF	1	4	1	1	1		
	Subtract memory from	A ← (A) − (M)	IMM	A0	lii	2	1-	-	1	\$	\$
SUB #opr	accumulator	[··· k.v ·····	DIR	В0	dd	3		l			
SUB opr		İ	EXT	CO	hh II	4			Į į		
SUB opr	i		IX2	D0	ee ff	5		1	1		
SUB opr,X			IX1	E0	11	4	1		ĺ		1
SUB opr,X			lix	F0	1	3					1
SUB,X		PC ← (PC) + 1; push (PCL)	INH	83		10	+_	1	├-	┢	╁
SWI	Software interrupt	P ← (PC) + 1, push (PCH)  SP ← (SP) - 1; push (PCH)  SP ← (SP) - 1; push (X)  SP ← (SP) - 1; push (CCR)  SP ← (SP) - 1; push (CCR)  SP ← (SP) - 1; L ← 1  PCH ← Interrupt vector hi byte  PCL ← Int. vector low byte		83							
TAX	Transfer accumulator to index register	X ← (A)	INH	97		2	-	-	_	-	-
TST opr	Test memory or register for	(M) - \$00	DIR	3D	dd	4	-	-	\$	\$	-
TSTA	negative or zero		INH	4D		3	1	1	1	ĺ	ĺ
TSTX			INH	5D	1	3	1		1	1	
l		1	IX1	6D	l <sub>ff</sub>	5	1	1	1		
TST opr,X			ix	7D	1	4	1				1
TST ,X TXA	Transfer index register to accumulator	A ← (X)	INH	9F		2	-	-	-	-	F
WAIT	Enable interrupts; halt CPU		INH	8F		2	T -	0	1-	-	T-
I WATE	Enable interrupts; hall GPU	1	1						1		

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### 12.4 Opcode Map

Table 12-13 is an opcode map of the M68HC05 instruction set.

ட	Bit Manipulation	pulation	Branch		Reac	Read-Modify-Write	Write		Control	trol			Registe	Register/Memory			
2	$\neg$	2	1	HIO	E	I Z	×	×	Ĭ	HN	Z Z	DIR	EXT	IX2	-X	×	
•		-	2	6	4	5	9	7	•	6	4	8	ပ	۵	ш	u.	Ξ.
BRSETO 3 DIR		BSET(	BRA 2 REL	NEG 5	NEGA 1 INH	NEGX 1 INH	NEG 2 IX1	NEG 5	BTI 9		SUB 2	SUB	SUB 4	SUB	SUB 4	SUB 1	0
BRCLR0 3 DIR	23°	BCLRC 2 DI	BRN 2 2 REL						BTS t			CMP 3	<b>၂</b> ၈	S C	, ,	CMP	-
BRSET1	3 <u>1</u> 2°	BSET 1	BHI 2		MUL 1						SBC 2		SB	SB.	, se	SBC	2
BRCLR1 3 DIR	BH.	BCLR1	BLS 2 REL	COM 2		COMX	COM 2 IX1	COMS	SWI 1NH			CPX 3		8	CPX 4	CPX C	6
BRSET2 3 DIR	T2s	BSET2	BCC 3	LSR 2	LSRA 1 INH	LSRX 1 INH	LSR 2 IX1	LSR 5			AND 2	AND BIR			AND 4	AND	4
BRCLR2 3 DIR	9.25 D.H.25	BCLR2	(4									BIT 2		<u> </u>	1 0	BIT 3	2
BRSET3	T3 DIR	BSET3 2 DIR	BNE 3	ROR 2 DIR	RORA 1 INH	RORX	ROR 6	ROR x			LDA 2	LDA 3	] = _	2	] = ,	LDA	٠
3RCI	BRCLR3	BCLF	(7)	ASR 2	ASBA 1 INH	ASRX 1 INH	ASB 2	ASB 1		TAX		STA		ol c		STA	7
BRSI	BRSET4	BSET4 2 DIR	BHCC 2 REL	ASL/LSL 2 DIR	ASIALSIA 1 INH	ASLXSLX 1 INH	ASL/LSL 2 IX1	ASL/LSL			EOR 2	EOR 3		) ~		EOB	
3RCI		BCLR4 2 DIR	BHCS 2 REL	ROL 2	ROLA	ROLX 3	2 RoL 6	POL 5		SEC 2	ADC 2	ADC 3	, e	) e	٥ ا١	ADC 3	6
BRSE	BRSETS 3 DIR	BSET5 2 DIR	BPL 2	(4)	DECA	DECX 1 INH	DEC 6	DEC 5		CLI 2	OBA 2	ORA DIR	۱ -	8	E	ORA	4
3RCI	BRCLR5	BCLR5	~							SEI 2	ADD 2	ADD 3				ADD	•
BRSI			BMC 3	INC 5 2 DIR	INCA 3	INCX 3	INC 6 2 IX1	NC ×		RSP 1	8	JMP	JMP 3	¥	۱ ۸	JMP	ပ
BRC	BRCLR6 3 DIR		BMS 2	TST 2	TSTA 1	TSTX INH	TST 5	TST t		NOP 2	BSR 6 2 REL 2	JSR DIR	St	JSR	ड	JSH	٥
BRSE	BRSET7 3 DIR		BIL 2						STOP		LDX 2	LDX 3		LDX	. 1	LDX	ш
32C	BRCLR7 3 DIR	BCLR7 2 DIR	BIH 2 REL	CLR 2	CLRA	CLRX 3	CLR 6	CLR 5	WAIT 1	TXA 1 INH		STX A		STX 6		STX	ш
/IATI	ONS	ABBREVIATIONS FOR ADI	ADDRESSING MODES	MODES								LEGEND					
ar E	Inherent Immediate Direct	E XX			et Yset					Negen	er of Cycles	L L	High By	yte of Opce	High Byte of Opcode in Hexadecimal	adecimal	
Exter	ded	IX2	Indexed,	d, 16-Bit Offset	Offset			2	Opcode Mnem Number of Bytes/Addressing	Opcode Bytes/Addre	Opcode Mnemonic ytes/Addressing Mode	SUB	• ×	Low Byte	Low Byte of Opcode in Hexadecimal	in Hexade	cimal

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MC68HC705P6

# SECTION 13 ELECTRICAL SPECIFICATIONS

This section contains MCU electrical specifications and timing information.

### 13.1 Maximum Ratings

### CAUTION

To avoid damage to the MCU, do not exceed the values listed in Table 13-1 Maximum Ratings. Keep  $V_{IN}$  and  $V_{OUT}$  within the range  $V_{SS} \le (V_{IN} \text{ or } V_{OUT}) \le V_{DD}$ .

Table 13-1. Maximum Ratings

Rating	Symbol	Value	Unit
Supply Voltage	V <sub>DD</sub>	-0.3 to +7.0	V
Input Voltage	ViN	$V_{SS} - 0.3$ to $V_{DD} + 0.3$	V
EPROM Programming Voltage (IRQ/VPP Pin)	V <sub>PP</sub>	16.75	٧
Current Drain per Pin (Excluding V <sub>DD</sub> and V <sub>SS</sub> )	ı	25	mA

NOTE: Maximum values are not guaranteed operating values.

#### 13.2 Thermal Characteristics

Table 13-2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance Plastic SOIC	Reja	60 60	•c/w
Operating Temperature Range MC68HC705P6P, DW, S (Standard) MC68HC705P6CP, CDW, CS (Extended) MC68HC705P6VP, VDW, VS (Automotive) MC68HC705P6MP, MDW, MS (Automotive)	TA	0 to +70 -40 to +85 -40 to +105 -40 to +125	•℃
Storage Temperature Range	T <sub>STG</sub>	-65 to +150	.€

#### NOTES:

- 1. P = Plastic dual in-line package (PDIP)
- 2. DW = Small outline integrated circuit (SOIC)
- 3. S = Ceramic dual in-line package (Cerdip)
- 4. C = Extended temp. range (-40 to +85 °C)
- 5. V = Automotive temp. range (-40 to +105 °C)
- 6. M = Automotive temp. range (-40 to +125 °C)

MC68HC705P6 REV. 1 **ELECTRICAL SPECIFICATIONS** 

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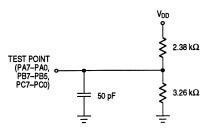


Figure 13-1. Test Load

#### 13.3 Power Considerations

The average chip junction temperature, T<sub>J</sub>, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \times \theta_{JA}) \tag{1}$$

where:

T<sub>A</sub> = Ambient temperature in °C

θ<sub>JA</sub> = Package thermal resistance, junction to ambient in °C/W

PD = PINT + PVO

PINT = ICC × VCC, watts — chip internal power

P<sub>I</sub>/<sub>O</sub> = Power dissipation on input and output pins — user-determined

For most applications P<sub>I/O</sub> « P<sub>INT</sub> and can be neglected.

The following is an approximate relationship between  $P_D$  and  $T_J$  (if  $P_{I/O}$  is neglected):

$$P_D = K \div (T_J + 273 \, ^{\circ}C)$$
 (2)

Solving equations (1) and (2) for K gives:

$$K = P_A \times (T_A + 273 \, ^{\circ}C) + R_{\theta JA} \times P_D \tag{3}$$

where K is a constant pertaining to the particular part. K can be determined from equation (3) by measuring  $P_D$  (at equilibrium) for a known  $T_A$ . Using this value of K, the values of  $P_D$  and  $T_J$  can be obtained by solving equations (1) and (2) iteratively for any value of  $T_A$ .

MOTOROLA 13-2 **ELECTRICAL SPECIFICATIONS** 

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### 13.4 DC Electrical Characteristics ( $V_{DD} = 5.0 \text{ Vdc}$ )

Table 13-3. DC Electrical Characteristics ( $V_{DD} = 5.0 \text{ Vdc}$ )

Characteristic	Symbol	Min	Тур	Max	Unit
Output Voltage I <sub>LOAD</sub> = 10.0 μA I <sub>LOAD</sub> = –10.0 μA	Vol.	— V <sub>DD</sub> – 0.1	_	0.1 —	V
Output High Voltage (I <sub>LOAD</sub> = -0.8 mA) PA7-PA0, PB7/SCK-PB5/SDO, PC7/V <sub>RH</sub> -PC3/AN3, PC2-PC0, PD5, TCMP	VoH	V <sub>DD</sub> – 0.8	_		٧
Output Low Voltage (I <sub>LOAD</sub> = 1.6 mA) PA7-PA0, PB7/SCK-PB5/SDO, PC7/V <sub>RH</sub> -PC3/AN3, PC2-PC0, PD5, TCMP	Val		_	0.4	٧
Input High Voltage PA7-PA0, PB7/SCK-PB5/SDO, PC7/V <sub>RH</sub> -PC3/AN3, PC2-PC0, PD5, PD7/TCAP, IRQ/V <sub>PP</sub> , RESET, OSC1	ViH	0.7 × V <sub>DD</sub>	_	V <sub>DD</sub>	٧
Input Low Voltage PA7-PA0, PB7/SCK-PB5/SDO, PC7/VRH-PC3/AN3, PC2-PC0, PD5, PD7/TCAP, IRQ/VPP, RESET, OSC1	VIL	Vss	_	0.2 × V <sub>DD</sub>	٧
Supply Current (NOTES 3–6) RUN WAIT (A/D Converter On) WAIT (A/D Converter Off)	I <sub>DD</sub>	=	4.0 2.0 1.3	7.0 4.0 2.0	mA mA mA
STOP 25 °C 0 to 70 °C (Standard) -40 to 125 °C		_ 	2 —	30 50 100	μΑ μΑ μΑ
I/O Ports Hi-Z Leakage Current PA7-PA0, PB7-PB5, PC7-PC0, PD5	lıL		_	±10	μА
A/D Ports Hi-Z Leakage Current	loz	_		±1	μА
Input Current RESET,IRQ/V <sub>PP</sub> , OSC1, PD7/TCAP	lin		_	±1	μА
Capacitance Ports (as Input or Output) RESET, IRQ/VPP	Cout C <sub>IN</sub>		_	12 8	pF pF
Programming Voltage	V <sub>PP</sub>	16.25	16.5	16.75	V
Programming Current	Ірр		5	10	mA
Programming Time per Byte	tEPGM	4			ms

#### NOTES:

- 1.  $V_{DD}$  = 5.0 Vdc  $\pm$  10%,  $V_{SS}$  = 0 Vdc,  $T_A$  =  $T_L$  to  $T_H$ , unless otherwise noted.
- 2. Typical values at midpoint of voltage range, 25°C only.
- RUN (operating) I<sub>DD</sub> and WAIT I<sub>DD</sub> measured using external square wave clock source (fosc = 4.2 MHz); all inputs 0.2 V from rail; no dc loads; less than 50 pF on all outputs; C<sub>L</sub> = 20 pF on OSC2.
- 4. WAIT IDD and STOP IDD: all ports configured as inputs; VIL = 0.2 V; VIH = VDD 0.2 V.
- 5. STOP  $I_{DD}$  measured with OSC1 = VSS.
- 6. WAIT  $I_{DD}$  is affected linearly by the OSC2 capacitance.

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### 13.5 DC Electrical Characteristics ( $V_{DD} = 3.3 \text{ Vdc}$ )

Table 13-4. DC Electrical Characteristics (V<sub>DD</sub> = 3.3 Vdc)

Characteristic	Symbol	Min	Тур	Max	Unit
Output Voltage (I <sub>LOAD</sub> ≤ 10.0 μA)	Vol Voh	 V <sub>DD</sub> = 0.1	=	0.1 —	v
Output High Voltage (I <sub>LOAD</sub> = -0.2 mA) PA7-PA0, PB7/SCK-PB5/SDO, PC7/V <sub>RH</sub> -PC3/AN3, PC2-PC0, PD5, TCMP	V <sub>ОН</sub>	V <sub>DD</sub> - 0.3	_		٧
Output Low Voltage (I <sub>LOAD</sub> = 0.4 mA) PA7-PA0, PB7/SCK-PB5/SDO, PC7/V <sub>RH</sub> -PC3/AN3, PC2-PC0, PD5, TCMP	Vol		_	0.3	v
Input High Voltage PA7-PA0, PB7/SCK-PB5/SDO, PC7/V <sub>RH</sub> -PC3/AN3, PC2-PC0, PD5, PD7/TCAP, IRQ/V <sub>PP</sub> , RESET, OSC1	V <sub>IH</sub>	0.7×V <sub>DD</sub>	_	V <sub>DD</sub>	v
Input Low Voltage PA7-PA0, PB7/SCK-PB5/SDO, PC7/V <sub>RH</sub> -PC3/AN3, PC2-PC0, PD5, PD7/TCAP, IRQ/V <sub>PP</sub> , RESET, OSC1	VIL	V <sub>SS</sub>	_	0.2×V <sub>DD</sub>	v
Data-Retention Mode Supply Voltage	V <sub>RM</sub>	2.0		_	٧
Supply Current (NOTES 3-6) RUN WAIT(A/D Converter On) WAIT (A/D Converter Off) STOP 25°C 0 to 70 °C (Standard) -40 to +125 °C	ООО		1.8 1.0 0.6 2.0	2.5 1.4 1.0 20 40 50	mA mA mA μA μA
I/O Ports Hi-Z Leakage Current PA7-PA0, PB7/SCK-PB5/SDO, PC7/V <sub>RH</sub> -PC3/AN3, PC2-PC0, PD5	IIL	_		±10	μ <b>А</b>
Input Current_ RESET, IRQ/V <sub>PP</sub> , OSC1, PD5, PD7/TCAP	lin		_	±1	μА
Capacitance Ports (as Input or Output) RESET, IRQ/V <sub>PP</sub> , PD5, PD7/TCAP	C <sub>OUT</sub> C <sub>IN</sub>		_	12 8	pF pF

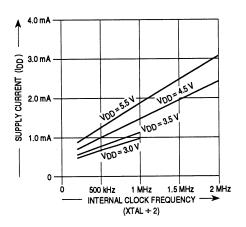
#### NOTES:

- 1.  $V_{DD}$  = 3.3 Vdc  $\pm$  10%,  $V_{SS}$  = 0 Vdc,  $T_A$  =  $T_L$  to  $T_H$  unless otherwise noted.
- 2. Typical values at midpoint of voltage range, 25 °C only.
- 3. RUN (operating)  $I_{DD}$  and WAIT  $I_{DD}$  measured using external square wave clock source (fosc = 2.1 MHz); all inputs 0.2 V from rail; no dc loads; less than 50 pF on all outputs;  $C_L$  = 20 pF on OSC2.
- 4. WAIT I<sub>DD</sub> and STOP I<sub>DD</sub>: all ports configured as inputs;  $V_{IL}$  = 0.2 V,  $V_{IH}$  =  $V_{DD}$  0.2 V.
- 5. STOP  $I_{DD}$  measured with OSC1 =  $V_{SS}$ .
- 6. WAIT IDD is affected linearly by the OSC2 capacitance.

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**ELECTRICAL SPECIFICATIONS** 

MC68HC705P6



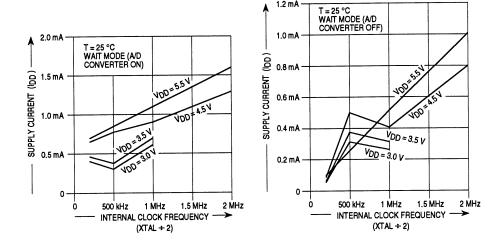


Figure 13-2. Typical  $I_{DD}$  vs Internal Clock Frequency (T = 25  $^{\circ}$ C)

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MOTOROLA 13-5

For More Information On This Product, Go to: www.freescale.com

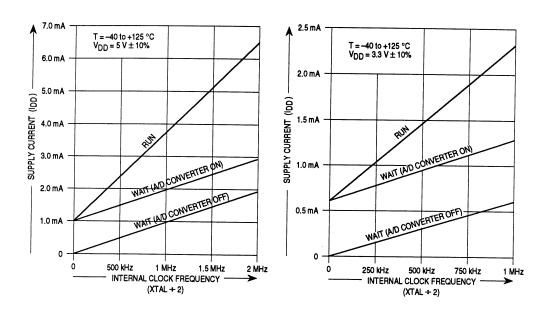


Figure 13-3. Typical I<sub>DD</sub> vs Internal Clock Frequency (T = -40 °C to +125 °C)

MOTOROLA 13-6 **ELECTRICAL SPECIFICATIONS** 

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### 13.6 A/D Converter Characteristics

Table 13-5. A/D Converter Characteristics

Characteristic	Min	Max	Unit
Resolution	8	8	Bit
Absolute Accuracy (4.0 > V <sub>RH</sub> > V <sub>DD</sub> ) (NOTE 2)	_	±1-1/2	LSB
Conversion Range (VRH Pin)	V <sub>SS</sub>	V <sub>DD</sub>	V
Conversion Time (Includes Sampling Time) External Clock (XTAL) Internal RC Oscillator (ADRC = 1)	32 32	32 32	t <sub>AD</sub> μs
Monotonicity	Inher	ent (Within	Total Error)
Zero Input Reading (VIN = 0 V)	00	01	Hex
Full-Scale Reading (VIN = VRH)	FF	F	Hex
Sample Acquisition Time (NOTE 3) External Clock (XTAL) Internal RC Oscillator (ADRC) = 1	12	12 12	t <sub>AD</sub> μs
Input Capacitance PC6/AN0, PC5/AN1, PC4/AN2, PC3/AN3	_	12	pF
Analog Input Voltage	Vss	V <sub>RH</sub>	٧
Input Leakage (NOTE 5) PC6/AN0, PC5/AN1, PC4/AN2, PC3/AN3 Vян	=	±1 ±1	μ <b>Α</b> μ <b>Α</b>

#### NOTES:

- 1.  $V_{DD}$  = 5.0 Vdc  $\pm 10$  %,  $V_{SS}$  = 0 Vdc,  $T_A$  =  $T_L$  to  $T_H$ , unless otherwise noted.
- 2. A/D accuracy may decrease proportionately as  $\ensuremath{V_{RH}}$  is reduced below 4.0 V.
- 3. Source impedances greater than 10 kohm adversely affect internal RC charging time during input sampling.
- 4.  $t_{AD} = t_{CYC}$  if clock source is MCU.
- 5. The external system error caused by input leakage current is approximately equal to the product of R source and input current.

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### 13.7 Control Timing $(V_{DD} = 5.0 \text{ Vdc})$

Table 13-6. Control Timing  $(V_{DD} = 5.0 \text{ Vdc})$ 

Characteristic	Symbol	Min	Max	Unit
Oscillator Frequency Crystal Option External Clock Option	fosc	— dc	4.2 4.2	MHz MHz
Internal Operating Frequency Crystal (fosc + 2) External Clock (fosc + 2)	for	— dc	2.1 2.1	MHz MHz
Cycle Time	tcyc	480	_	ns
Crystal Oscillator Startup Time	toxov		100	ms
STOP Recovery Startup Time (Crystal Oscillator)	tilch	***	100	ms
RESET Pulse Width	t <sub>RL</sub>	1.5	_	tcyc
Timer Resolution (NOTE 2)	tRESL	4.0	_	tcyc
Interrupt Pulse Width Low (Edge-Triggered)	tilih	125	_	ns
Interrupt Pulse Period	tiLIL	(NOTE 3)	_	tcyc
OSC1 Pulse Width	ton, tol	90	_	ns
A/D On Current Stabilization Time	tadon		100	μs

#### NOTES:

- 1.  $V_{DD}$  = 5.0 Vdc  $\pm$  10%,  $V_{SS}$  = 0 Vdc,  $T_A$  =  $T_L$  to  $T_H$ , unless otherwise noted.
- Since a 2-bit prescaler in the timer must count four internal cycles (t<sub>CYC</sub>), this is the limiting minimum factor in determining the timer resolution.
- The minimum period t<sub>ILIL</sub> should not be less than the number of cycle times it takes to execute
  the interrupt service routine plus 19 t<sub>CYC</sub>.

MOTOROLA 13-8 **ELECTRICAL SPECIFICATIONS** 

MC68HC705P6

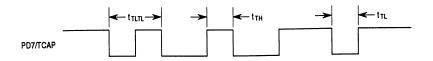
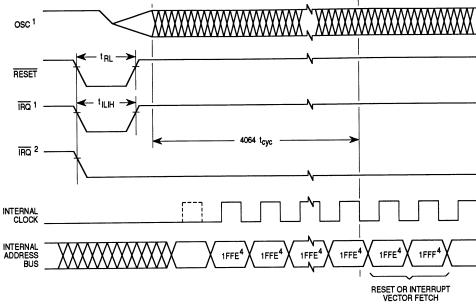


Figure 13-4. TCAP Timing



#### NOTES:

- Represents the internal clocking of OSC1 pin.
- 2. External interrupt edge-triggered mask option.
- External interrupt edge- and level-triggered mask option.
- 4. Reset vector shown for timing example.

Figure 13-5. STOP Recovery Timing

MC68HC705P6 REV. 1 **ELECTRICAL SPECIFICATIONS** 

MOTOROLA

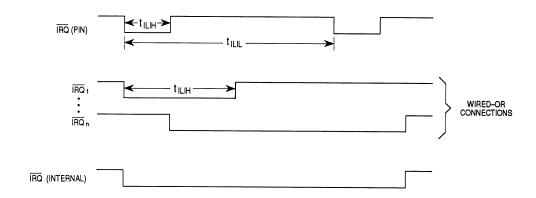


Figure 13-6. External Interrupt Timing

### 13.8 Control Timing $(V_{DD} = 3.3 \text{ Vdc})$

Table 13-7. Control Timing  $(V_{DD} = 3.3 \text{ Vdc})$ 

Characteristic	Symbol	Min	Max	Unit
Oscillator Frequency Crystal Option External Clock Option	fosc	_ dc	2.0	MHz MHz
Internal Operating Frequency Crystal (fosc + 2) External Clock (fosc + 2)	fop	_ dc	1.0	MHz MHz
Cycle Time	tcyc	1	-	ms
Crystal Oscillator Startup Time	toxov	_	100	ms
STOP Recovery Startup Time (Crystal Oscillator)	tilch	_	100	ms
RESET Pulse Width	t <sub>RL</sub>	1.5	-	tcyc
Timer Resolution (NOTE 2)	†RESL	4.0	_	tcyc
Interrupt Pulse Width Low (Edge-Triggered)	tiLiH	250	-	ns
Interrupt Pulse Period	t <sub>ILIL</sub>	(NOTE 3)	-	tcyc
OSC1 Pulse Width	toH, toL	200	_	ns

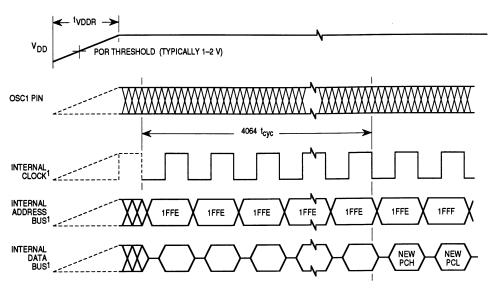
#### NOTES:

- 1.  $V_{DD}$  = 3.3 Vdc  $\pm$  10%,  $V_{SS}$  = 0 Vdc,  $T_A$  =  $T_L$  to  $T_H$ , unless otherwise noted.
- 2. Because a 2-bit prescaler in the timer must count four internal cycles (t<sub>CYC</sub>), this is the limiting minimum factor in determining the timer resolution.
- 3. The minimum period  $t_{\text{ILIL}}$  should not be less than the number of cycle times it takes to execute the interrupt service routine plus 19 tcyc.

**MOTOROLA** 13-10

**ELECTRICAL SPECIFICATIONS** 

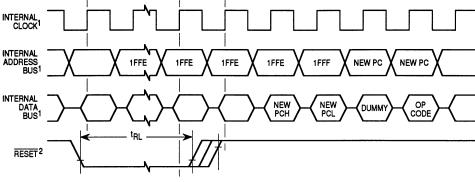
MC68HC705P6



#### NOTES:

1. Internal clock, internal address bus, and internal data bus are not available externally.

Figure 13-7. Power-On Reset Timing



#### NOTES:

- 1. Internal clock, internal address bus, and internal data bus signals are not available externally.
- 2. Next rising edge of internal clock after rising edge of RESET initiates reset sequence.

Figure 13-8. External Reset Timing

MC68HC705P6 REV. 1 **ELECTRICAL SPECIFICATIONS** 

MOTOROLA

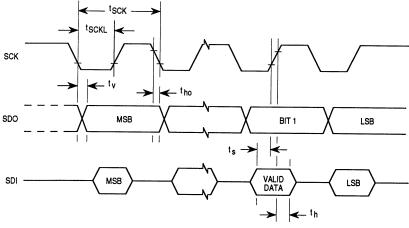
### 13.9 SIOP Timing $(V_{DD} = 5.0 \text{ Vdc})$

Table 13-8. SIOP Timing  $(V_{DD} = 5.0 \text{ Vdc})$ 

Characteristic	Symbol	Min	Max	Unit
Frequency of Operation  Master Slave	fsiop(m) fsiop(s)	0.25 dc	0.25 525	f <sub>OP</sub> kHz
Cycle Time Master Slave	tsck(m)	4.0	4.0 1920	tcyc ns
Clock (SCK) Low Time (fop = 2.1 MHz)	tsckl	932	_	ns
SDO Data Valid Time	tv	_	200	ns
SDO Hold Time	tно	0	_	ns
SDI Setup Time	ts	100		ns
SDI Hold Time	tн	100		ns

#### NOTES:

- 1.  $V_{DD}$  = 5.0 Vdc  $\pm$  10%,  $V_{SS}$  = 0 Vdc,  $T_A$  =  $T_L$  to  $T_H$ , unless otherwise noted.
- 2.  $f_{OP} = f_{OSC} + 2 = 2.1$  MHz maximum;  $t_{CYC} = 1 + f_{OP}$ .
- 3. In master mode, SCK is generated by dividing the internal clock (for) by 4.



#### NOTES:

- 1. This diagram applies to both the master and slave modes of the SIOP.
- 2. Bit order is shown for MSB first option.

Figure 13-9. SIOP Timing

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**ELECTRICAL SPECIFICATIONS** 

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13.10 SIOP Timing  $(V_{DD} = 3.3 \text{ Vdc})$ 

Table 13-9. SIOP Timing  $(V_{DD} = 3.3 \text{ Vdc})$ 

Characteristic	Symbol	Min	Max	Unit
Frequency of operation Master Slave	fsiop(M) fsiop(s)	0.25 dc	0.25 250	fop kHz
Cycle Time Master Slave	tsck(M)	4.0 -	4.0 4000	tcyc ns
Clock (SCK) Low Time (fop = 1.0 MHz)	tsckl	1980	_	ns
SDO Data Valid Time	tv	-	400	ns
SDO Hold Time	tно	0	_	ns
SDI Setup Time	ts	200	_	ns
SDI Hold Time	tн	200	_	ns

- 1.  $V_{DD}$  = 3.3 Vdc  $\pm$  10%,  $V_{SS}$  = 0 Vdc,  $T_A$  =  $T_L$  to  $T_H$ , unless otherwise noted. 2.  $f_{OP}$  = 1.0 MHz maximum.

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**ELECTRICAL SPECIFICATIONS** 

**MOTOROLA** 

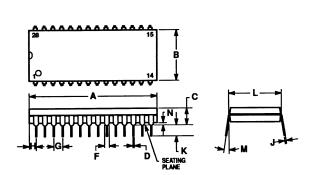
MOTOROLA 13-14 **ELECTRICAL SPECIFICATIONS** 

MC68HC705P6 REV. 1

### **SECTION 14** MECHANICAL SPECIFICATIONS

This section gives the dimensions of the plastic dual in-line package (PDIP), ceramic dual in-line package (cerdip), and small outline integrated circuit (SOIC) package.

### 14.1 PDIP



NOTES:

1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25mm (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.

2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

	MILLIM	ETERS	INC	HES
DIM	MIN	MAX	MIM	MAX
A	36.45	37.21	1.435	1.465
В	13.72	14.22	0.540	0.560
С	3.94	5.08	0.155	0.200
D	0.36	0.56	0.014	0.022
F	1.02	1.52	0.040	0.060
G	2.54	BSC	0.100	
H	1.65	2.16	0.065	
7	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
T	15.24	BSC	0.600	
M	o	15°	%	15°
N	0.51	102	0.020	0.040

**CASE 710-02 ISSUE B** 

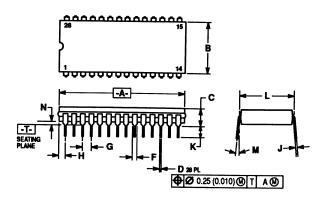
**Figure 14-1.** 

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MECHANICAL SPECIFICATIONS

**MOTOROLA** 

### 14.2 Cerdip



- NOTES:

  1. DIM A AND B INCLUDES MENISCUS.

  2. DIM LTO CENTER OF LEADS WHEN FORMED PARALLEL.

  3. DIMENSIONING AND TOLERANCING PER ANSI Y14.5.
- 1982. 4. CONTROLLING DIM: INCH.

	NCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	1.435	1.490	36.45	37.84
В	0.500	0.605	12.70	15.36
С	0.160	0.230	4.06	5.84
0	0.015	0.022	0.38	0.55
F	0.050	0.065	1.27	1.65
G	0.100 BSC		2.54 BSC	
J	0.008	0.012	0.20	0.30
K	0.125	0.160	3.18	4.06
L	0.600 BSC		15.24 BSC	
M	°	15°	0°	15°
N	0.020	0.050	0.51	1.27

**CASE 733B-02 ISSUE B** 

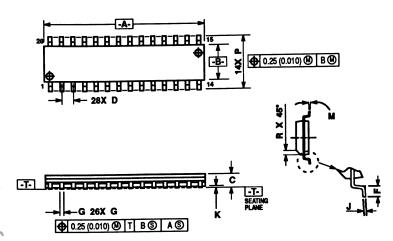
Figure 14-2.

**MOTOROLA** 14-2

MECHANICAL SPECIFICATIONS

MC68HC705P6

### 14.3 SOIC



- NOTES:
  1. DIMENSIONS "A" AND "B" ARE DATUMS AND "T" IS A DATUM SURFACE.
  2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  1. CONTROLLING DIMENSION: MILLIMETER.
  4. DIMENSION "A" AND "B" DO NOT INCLUDE MOLD PROTRUSION 0.15 (0.005) PER SIDE.
  6. DIMENSION "D' DOES NOT INCLUDE DAMBAR PROTRUSION, ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF "D" DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	17.80	18.05	0.701	0.711
В	7.40	7.60	0.292	0.299
C	2.35	2.65	0.093	0.104
0	0.35	0.49	0.014	0.019
F	0.41	0.90	0.016	0.035
G	1.27 BSC		0.050 BSC	
J	0.229	0.317	0.0090	
K	0.127	0.292	0.0050	0.0115
M	00	8°	8	8
P	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

**CASE 751F-04 ISSUE E** 

Figure 14-3.

MC68HC705P6 REV. 1

MECHANICAL SPECIFICATIONS

**MOTOROLA** 

MOTOROLA 14-4 MECHANICAL SPECIFICATIONS

MC68HC705P6 REV. 1